

ICF 9000

Standard

Customer Customer Part Number: Innodisk Part Number: Innodisk Model Name: Date:

Innodisk	Customer
Approver	Approver

The Total Solution For Industrial Flash Storage



Table of contents

1.	INTRO	DDU	CTION	9
2.	FEATU	JRES)	9
3.	PIN A	SSI	SNMENT	11
4.	PIN D	ESC	RIPTION	13
5.	SPECI	FIC	ATIONS	17
	5.1	CE A	AND FCC COMPATIBILITY	17
	5.2	RoH	S COMPLIANCE	17
	5.3	Env	RONMENTAL SPECIFICATIONS	17
	5.3	3.1	Temperature Ranges	17
	5.3	3.2	Humidity	17
	5.3	3.3	Shock and Vibration	17
	5.3	3.4	Mean Time between Failures (MTBF)	17
	5.3	3.5	Write Protect Function Support	18
	5.3	3.6	Wear-Leveling	18
	5.3	3.7	Reliability	19
	5.4	MEC	HANICAL DIMENSIONS	19
	5.5	ELEC	TRICAL SPECIFICATIONS	21
	5.5.1	DC (CHARACTERISTIC	21
	5.5.2	ТІМІ	NG SPECIFICATIONS	21
	5.	5.2.1	True IDE PIO Mode Read/Write Timing Specification	21
	5.	5.2.2	True IDE Multiword DMA Mode Read/Write Timing Specification	23
	5.	5.2.3	True IDE Ultra DMA Mode Data Burst Timing Specification	24
	5.6	TRAI	NSFER FUNCTION	26
	5.0	6.1	True IDE Mode I/O Transfer Function	26
	5.7	Con	FIGURATION REGISTER	27
	5.7.1	Con	FIGURATION OPTION REGISTER (200H IN ATTRIBUTE MEMORY)	27
	5.7.2	PIN	REPLACEMENT REGISTER (204H IN ATTRIBUTE MEMORY)	28
	5.7.3	Soc	KET AND COPY REGISTER (206H IN ATTRIBUTE MEMORY)	28
	5.8	Sof	TWARE INTERFACE	29
	5.8.1	Trui	IDE Mode Addressing	29
	5.9	Har	DWARE RESET	34
	5.10	Pow	ER ON RESET	34
	5.11	SUPI	PORT IDE COMMANDS	35
	5.11.1	. Сне	CK POWER MODE –E5H	36
	5.11.2	EXEC	CUTE DEVICE DIAGNOSTIC - 90H	36
	5.11.3	B FLUS	SH CACHE- E7H	37

2



6.

5.11.4 IDENTIFY DEVICE- ECH							
5.11.5 IDLE -97H OR E3H							
5.11.6 IDLE IMMEDIATE – 95H OR E1H							
5.11.7 REA	AD BUFFER – E4H	49					
5.11.8 REA	AD DMA – C8H	50					
5.11.9 REA	AD SECTOR(S) - 20H	51					
5.11.10	Read Verify Sector(s) – 40H	51					
5.11.11	SET FEATURES – EFH	52					
5.11.12	SET MULTIPLE MODE – C6H	53					
5.11.13	SET SLEEP MODE –E6H	53					
5.11.14	STANDBY -E2H	54					
5.11.15	STANDBY IMMEDIATE -E0H	54					
5.11.16	Write Buffer – E8H	55					
5.11.17	Write DMA – Cah	55					
5.11.18	WRITE MULTIPLE- C5H	56					
5.11.19	Write Sector(s) – 30H	59					
5.11.20	SECURITY SET PASSWORD- F1H	60					
5.11.21	SECURITY UNLOCK- F2H	62					
5.11.22	SECURITY ERASE PREPARE- F3H	65					
5.11.23	SECURITY ERASE UNIT- F4H	66					
5.11.24	SECURITY FREEZE LOCK- F5H	69					
5.11.25	SECURITY DISABLE PASSWORD- F6H	71					
5.11.26	SMART	73					
5.11.27	SMART READ DATA	74					
5.11.28	SMART ENABLE OPERATIONS	76					
5.11.29	SMART DISABLE OPERATIONS	77					
DEVICE PARAMETERS 78							
PART NUI	MBFR RUI F	79					



REVISION HISTORY

Revision	Description	Date			
1.0	First release	Nov. 2012			
1.1	Update performance	Dec. 2012			
1.2	Modify part number	Dec. 2012			
1.3	Modify performance	Jan. 2013			
	Update CE,FCC				
1.4	Modify device parameter Feb. 20				
1.5	Modify device parameter March. 2				
1.6	Modify device parameter May. 2013				
1.7	Modify part number rule May. 2013				
1.8	Add TBW Aug. 2013				
1.9	Modify performance Feb. 2014				
2.0	Modify part number rule June. 2014				
2.1	Add 1GB capacity July. 2014				
2.2	Modify TBW based on NAND Flash specifications January. 2015				



List of Tables

TABLE 2: ICF9000 PIN DESCRIPTION 13 TABLE 3: SHOCK/VIBRATION TEST FOR ICF9000 17 TABLE 4: ICF9000 MTBF 18 TABLE 5: TRUE IDE PIO MODE READ/WRITE TIMING 22 TABLE 6: TRUE IDE PIO MODE READ/WRITE TIMING 23 TABLE 6: TRUE IDE MODE LYO FUNCTION 26 TABLE 9: CONFIGURATION OPTION REGISTER 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 25 TABLE 16: DATA REGISTER 25 TABLE 16: DATA REGISTER 30 TABLE 19: SECTOR REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER HIGH REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 32	Table 1: ICF9000 PIN Assignments	11
TABLE 4: ICF9000 MTBF 18 TABLE 5: TRUE IDE PIO MODE READ/WRITE TIMING 22 TABLE 6: TRUE IDE MULTIWORD DMA READ/WRITE TIMING 23 TABLE 7: TIMING DIAGRAM, ULTRA DMA MODE 0-6 24 TABLE 8: TRUE IDE MODE I/O FUNCTION 26 TABLE 9: CONFIGURATION OPTION REGISTER 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 25 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER LOW REGISTER 31 TABLE 25: DEVICE / HEAD REGISTER 31 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION	Table 2: ICF9000 PIN DESCRIPTION	13
TABLE 5: TRUE IDE PIO MODE READ/WRITE TIMING. 22 TABLE 6: TRUE IDE MULTIWORD DMA READ/WRITE TIMING. 23 TABLE 7: TIMING DIAGRAM, ULTRA DMA MODE 0-6 24 TABLE 8: TRUE IDE MODE I/O FUNCTION. 26 TABLE 9: CONFIGURATION OPTION REGISTER. 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER. 27 TABLE 11: PIN REPLACEMENT REGISTER. 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER LOW REGISTER 31 TABLE 25: DEVICE CONTROL REGISTER 31 TABLE 26: DEVICE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 31: EXECUTE DEVICE D	Table 3: Shock/Vibration Test for ICF9000	17
TABLE 6: TRUE IDE MULTIWORD DMA READ/WRITE TIMING 23 TABLE 7: TIMING DIAGRAM, ULTRA DMA MODE 0-6 24 TABLE 8: TRUE IDE MODE I/O FUNCTION 26 TABLE 9: CONFIGURATION OPTION REGISTER 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 25 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 32 TABLE 26: DEVICE ONTROL REGISTER 32 TABLE 27: TIMING DIAGRAM, HADWARE RESET 34 TABLE 28: TIMING DIAGRAM, HOWER ON RESET 34 <td>Table 4: ICF9000 MTBF</td> <td>18</td>	Table 4: ICF9000 MTBF	18
TABLE 7: TIMING DIAGRAM, ULTRA DMA MODE 0-6 24 TABLE 8: TRUE IDE MODE I/O FUNCTION 26 TABLE 9: CONFIGURATION OPTION REGISTER 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 25 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 32 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 29: IDE COMMANDS 36	TABLE 5: TRUE IDE PIO MODE READ/WRITE TIMING	22
TABLE 8: TRUE IDE MODE I/O FUNCTION. 26 TABLE 9: CONFIGURATION OPTION REGISTER 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 28 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 22: STUDINGE HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 25: DEVICE ONTROL REGISTER 32 TABLE 26: DRIVE ADDRESS REGISTER 32 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34	Table 6: True IDE Multiword DMA Read/Write Timing	23
TABLE 9: CONFIGURATION OPTION REGISTER 27 TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 19: SECTOR NUMBER REGISTER 31 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 32 TABLE 25: DEVICE ADDRESS REGISTER 32 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36	Table 7: Timing Diagram, Ultra DMA Mode 0-6	24
TABLE 10: INFORMATION FOR CONFIGURATION OPTION REGISTER 27 TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 26 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 31 TABLE 25: DEVICE CONTROL REGISTER 32 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: F	Table 8: True IDE Mode I/O Function	26
TABLE 11: PIN REPLACEMENT REGISTER 28 TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 31 TABLE 25: DEVICE CONTROL REGISTER 32 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: FLUS	Table 9: Configuration Option Register	27
TABLE 12: INFORMATION FOR PIN REPLACEMENT REGISTER 28 TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 35: FLUSH CACHE COMMAND FOR REROR OUTPUT INFORMATION 38	Table 10: Information for Configuration Option Register	27
TABLE 13: SOCKET AND COPY REGISTER 28 TABLE 14: INFORMATION FOR SOCKET AND COPY REGISTER 29 TABLE 15: TRUE IDE MODE I/O DECODING 29 TABLE 16: DATA REGISTER 30 TABLE 17: ERROR REGISTER 30 TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: Flush CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: Flush CACHE COMMAND FOR REFORMAND OUTPUT INFORMATION 37 TABLE 35: Flush CACHE COMMAND FOR REFORMAND OUTPUT INFORMATION 38	Table 11: Pin Replacement Register	28
Table 14: Information for Socket and Copy Register 29 Table 15: True IDE Mode I/O Decoding 29 Table 16: Data Register 30 Table 17: Error Register 30 Table 18: Feature Register 30 Table 19: Sector Count Register 30 Table 20: Sector Number Register 31 Table 21: Cylinder Low Register 31 Table 22: Cylinder High Register 31 Table 23: Device/Head Register 31 Table 24: Status Register 32 Table 25: Device Control Register 33 Table 26: Drive Address Register 33 Table 27: Timing Diagram, Hardware Reset 34 Table 28: Timing Diagram, Power On Reset 34 Table 29: IDE Commands 35 Table 30: Check power mode information 36 Table 31: Execute device diagnostic information 36 Table 33: Flush cache command for inputs information 37 Table 34: Flush cache command for normal output information 37 Table 35: Flush cache command for regron output information 38 Table 36: Identify device information 38 Table 37: IDENTIFY Device information <	Table 12: Information for Pin Replacement Register	28
Table 15: True IDE Mode I/O Decoding 29 Table 16: Data Register 30 Table 17: Error Register 30 Table 18: Feature Register 30 Table 19: Sector Count Register 30 Table 20: Sector Number Register 31 Table 21: Cylinder Low Register 31 Table 22: Cylinder High Register 31 Table 23: Device/Head Register 31 Table 24: Status Register 32 Table 25: Device Control Register 33 Table 26: Drive Address Register 33 Table 27: Timing Diagram, Hardware Reset 34 Table 28: Timing Diagram, Power On Reset 34 Table 29: IDE Commands 35 Table 31: Execute Device Diagnostic Information 36 Table 32: Diagnostic 36 Table 33: Flush Cache Command for Inputs Information 37 Table 34: Flush Cache Command for Rormation 37 Table 35: Flush Cache Command for Regron Output Information 38 Table 36: Identify Device Information 38 Table 37: IDENTIFY Device Information 38	TABLE 13: SOCKET AND COPY REGISTER	28
TABLE 16: DATA REGISTER 3C TABLE 17: ERROR REGISTER 3C TABLE 18: FEATURE REGISTER 3C TABLE 19: SECTOR COUNT REGISTER 3C TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: FLUSH CACHE COMMAND FOR RORMAL OUTPUT INFORMATION 37 TABLE 35: FLUSH CACHE COMMAND FOR REROR OUTPUT INFORMATION 38 TABLE 36: IDENTIFY DEVICE INFORMATION 38 TABLE 37: IDENTIFY DEVICE INFORMATION 38	Table 14: Information for Socket and Copy Register	29
TABLE 17: ERROR REGISTER 30 TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: FLUSH CACHE COMMAND FOR NORMAL OUTPUT INFORMATION 37 TABLE 35: FLUSH CACHE COMMAND FOR ERROR OUTPUT INFORMATION 38 TABLE 36: IDENTIFY DEVICE INFORMATION 38 TABLE 37: IDENTIFY DEVICE INFORMATION 38	Table 15: True IDE Mode I/O Decoding	29
TABLE 18: FEATURE REGISTER 30 TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: FLUSH CACHE COMMAND FOR NORMAL OUTPUT INFORMATION 37 TABLE 35: FLUSH CACHE COMMAND FOR ERROR OUTPUT INFORMATION 38 TABLE 36: IDENTIFY DEVICE INFORMATION 38 TABLE 37: IDENTIFY DEVICE INFORMATION 38 TABLE 37: IDENTIFY DEVICE INFORMATION 39	Table 16: Data Register	30
TABLE 19: SECTOR COUNT REGISTER 30 TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: FLUSH CACHE COMMAND FOR NORMAL OUTPUT INFORMATION 37 TABLE 35: FLUSH CACHE COMMAND FOR REROR OUTPUT INFORMATION 38 TABLE 36: IDENTIFY DEVICE INFORMATION 38 TABLE 37: IDENTIFY DEVICE INFORMATION 39	Table 17: Error Register	30
TABLE 20: SECTOR NUMBER REGISTER 31 TABLE 21: CYLINDER LOW REGISTER 31 TABLE 22: CYLINDER HIGH REGISTER 31 TABLE 23: DEVICE/HEAD REGISTER 31 TABLE 24: STATUS REGISTER 32 TABLE 25: DEVICE CONTROL REGISTER 33 TABLE 26: DRIVE ADDRESS REGISTER 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET 34 TABLE 29: IDE COMMANDS 35 TABLE 30: CHECK POWER MODE INFORMATION 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION 36 TABLE 32: DIAGNOSTIC 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION 37 TABLE 34: FLUSH CACHE COMMAND FOR NORMAL OUTPUT INFORMATION 37 TABLE 35: FLUSH CACHE COMMAND FOR ERROR OUTPUT INFORMATION 38 TABLE 36: IDENTIFY DEVICE INFORMATION 38 TABLE 37: IDENTIFY DEVICE INFORMATION 39	Table 18: Feature Register	30
TABLE 21: CYLINDER LOW REGISTER. 31 TABLE 22: CYLINDER HIGH REGISTER. 31 TABLE 23: DEVICE/HEAD REGISTER. 31 TABLE 24: STATUS REGISTER. 32 TABLE 25: DEVICE CONTROL REGISTER. 33 TABLE 26: DRIVE ADDRESS REGISTER. 33 TABLE 27: TIMING DIAGRAM, HARDWARE RESET. 34 TABLE 28: TIMING DIAGRAM, POWER ON RESET. 34 TABLE 29: IDE COMMANDS. 35 TABLE 30: CHECK POWER MODE INFORMATION. 36 TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION. 36 TABLE 32: DIAGNOSTIC. 36 TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION. 37 TABLE 34: FLUSH CACHE COMMAND FOR NORMAL OUTPUT INFORMATION. 37 TABLE 35: FLUSH CACHE COMMAND FOR ERROR OUTPUT INFORMATION. 38 TABLE 36: IDENTIFY DEVICE INFORMATION. 38 TABLE 37: IDENTIFY DEVICE INFORMATION. 39	Table 19: Sector Count Register	30
TABLE 22: CYLINDER HIGH REGISTER	Table 20: Sector Number Register	31
TABLE 23: DEVICE/HEAD REGISTER	Table 21: Cylinder Low Register	31
TABLE 24: STATUS REGISTER	Table 22: Cylinder High Register	31
TABLE 25: DEVICE CONTROL REGISTER	Table 23: Device/Head Register	31
TABLE 26: DRIVE ADDRESS REGISTER	Table 24: Status Register	32
TABLE 27: TIMING DIAGRAM, HARDWARE RESET	Table 25: Device Control Register	33
Table 28: Timing Diagram, Power On Reset	Table 26: Drive Address Register	33
TABLE 29: IDE COMMANDS	Table 27: Timing Diagram, Hardware Reset	34
TABLE 30: CHECK POWER MODE INFORMATION	Table 28: Timing Diagram, Power On Reset	34
TABLE 31: EXECUTE DEVICE DIAGNOSTIC INFORMATION	Table 29: IDE Commands	35
TABLE 32: DIAGNOSTIC	Table 30: Check power mode information	36
TABLE 33: FLUSH CACHE COMMAND FOR INPUTS INFORMATION	Table 31: Execute device diagnostic information	36
TABLE 34: FLUSH CACHE COMMAND FOR NORMAL OUTPUT INFORMATION	Table 32: Diagnostic	36
TABLE 35: FLUSH CACHE COMMAND FOR ERROR OUTPUT INFORMATION	Table 33: Flush cache command for inputs information	37
Table 36: Identify device information		
Table 36: Identify device information	Table 35: Flush cache command for error output information	38
Table 37: IDENTIFY DEVICE INFORMATION39	Table 36: Identify device information	38
Table 38: Idle information		
	Table 38: Idle information	48

5



6

TABLE 39:	IDLE IMMEDIATE INFORMATION	.49
TABLE 40:	READ BUFFER INFORMATION	.49
TABLE 41:	READ DMA INFORMATION	.50
TABLE 42:	READ SECTOR INFORMATION	.51
TABLE 43:	READ VERIFY SECTOR INFORMATION	.51
TABLE 44:	SET FEATURE INFORMATION	.52
TABLE 45:	FEATURE SUPPORTED	.52
TABLE 46:	SET MULTIPLE MODE INFORMATION	.53
TABLE 47:	SET SLEEP MODE INFORMATION	.53
TABLE 48:	STANDBY INFORMATION	.54
TABLE 49:	STANDBY IMMEDIATE INFORMATION	.54
TABLE 50:	WRITE BUFFER INFORMATION	.55
TABLE 51:	WRITE DMA INFORMATION	.55
TABLE 52:	WRITE MULTIPLE COMMAND FOR INPUTS INFORMATION	.56
TABLE 53:	WRITE MULTIPLE COMMAND FOR NORMAL OUTPUT INFORMATION	.57
TABLE 54:	WRITE MULTIPLE COMMAND FOR NORMAL OUTPUT INFORMATION	.57
TABLE 55:	WRITE SECTOR INFORMATION	.59
TABLE 56:	SECURITY SET PASSWORD COMMAND FOR INPUTS INFORMATION	.60
TABLE 57:	SECURITY SET PASSWORD COMMAND FOR NORMAL OUTPUTS INFORMATION	.60
TABLE 58:	SECURITY SET PASSWORD COMMAND FOR ERROR OUTPUTS INFORMATION	.61
TABLE 59:	SECURITY SET PASSWORD COMMAND'S DATA CONTENT	.62
TABLE 60:	Security Set password command's identifier and security level bit interaction .	.62
TABLE 61:	SECURITY UNLOCK COMMAND FOR INPUTS INFORMATION	.63
TABLE 62:	SECURITY UNLOCK COMMAND FOR INPUTS INFORMATION	.63
TABLE 63:	SECURITY UNLOCK COMMAND FOR INPUTS INFORMATION	.64
TABLE 64:	SECURITY ERASE PREPARE COMMAND FOR INPUTS INFORMATION	.65
TABLE 65:	SECURITY ERASE PREPARE COMMAND FOR NORMAL OUTPUTS INFORMATION	.65
TABLE 66:	SECURITY ERASE PREPARE COMMAND FOR ERROR OUTPUTS INFORMATION	.66
TABLE 67:	SECURITY ERASE UNIT COMMAND FOR INPUTS INFORMATION	.67
TABLE 68:	SECURITY ERASE UNIT COMMAND FOR NORMAL OUTPUTS INFORMATION	.67
TABLE 69:	SECURITY ERASE UNIT COMMAND FOR ERROR OUTPUTS INFORMATION	.68
TABLE 70:	SECURITY ERASE UNIT PASSWORD INFORMATION	.69
TABLE 71:	SECURITY FREEZE LOCK FOR INPUTS INFORMATION	.69
TABLE 72:	SECURITY FREEZE LOCK FOR NORMAL OUTPUTS INFORMATION	.70
TABLE 73:	SECURITY FREEZE LOCK FOR ERROR OUTPUTS INFORMATION	.70
TABLE 74:	SECURITY DISABLE PASSWORD COMMAND FOR INPUTS INFORMATION	.72
TABLE 75:	SECURITY DISABLE PASSWORD COMMAND FOR NORMAL OUTPUTS INFORMATION	.72
TABLE 76:	SECURITY DISABLE PASSWORD COMMAND FOR ERROR OUTPUTS INFORMATION	.72
TABLE 77:	SECURITY DISABLE PASSWORD COMMAND CONTENT	.73



TABLE 78: SMART FEATURE REGISTER VALUES	74
Table 79: SMART command for inputs information	74
TABLE 80: SMART COMMAND FOR NORMAL OUTPUTS INFORMATION	74
Table 81: SMART data structure	75
TABLE 82: SMART ENABLE COMMAND FOR INPUTS INFORMATION	76
TABLE 83: SMART COMMAND FOR NORMAL OUTPUTS INFORMATION	76
TABLE 84: SMART DISABLE COMMAND FOR INPUTS INFORMATION	77
TABLE 85: SMART COMMAND FOR NORMAL OUTPUTS INFORMATION	77
TABLE 86: DEVICE PARAMETER	78



List of Figures

FIGURE 1: MECHANICAL DIMENSION OF ICF9000	19
FIGURE 2: READ/WRITE TIMING DIAGRAM, PIO MODE	21
FIGURE 3: TRUE IDE MULTIWORD DMA MODE READ/WRITE TIMING	23
FIGURE 4: TIMING DIAGRAM POWER ON RESET	35



1. Introduction

The Innodisk Industrial CompactFlash® 9000 Memory Card (iCF9000) products provide high capacity solid-state flash memory that electrically complies with the True IDE Mode that is electrically compatible with an IDE disk drive. The original CF form factor card can be used in any system that has a CF slot. Designed to replace traditional rotating disk drives, Innodisk Industrial CompactFlash® 9000 Memory Cards are embedded solid-state data storage systems for mobile computing and the industrial work place. The Industrial CompactFlash® features an extremely lightweight, reliable, low-profile form factor. Industrial CompactFlash® 9000 (iCF9000) support advanced PIO (0-6), Multiword DMA (0-4), Ultra DMA (0-7) transfer mode, multi-sector transfers, and LBA addressing.



Figure 1:iCF 9000

2. Features

The Industrial ATA products provide the following system features:

- Capacities: 1GB/2GB/4GB/8GB/16GB/32GB/64GB
- Fully compatible with CompactFlash® specification version 6.0
- Fully compatible with PC Card Standard.
- Fully compatible with the IDE standard interface, ATA Standard
- Three access modes
 - True IDE Mode
 - PC Card Memory Mode
 - PC Card I/O Mode
- ECC (Error Correction Code) function: 72 bits/ per 1 Kbyte
- +3.3V/+5V single power supply operation
- Support Auto Stand-by and Sleep Mode.
- Power Consumption



- Quad:

Active mode

Read operation: 114 mA (max.)
Write operation: 188 mA (max.)
Power Down mode: 0.7 mA (max.)

• Support transfer modes: PIO(0-6), Multiword DMA (0-4) and Ultra DMA(0-7)

• MTBF 3,000,000 hours

• R/W performance:

Product name		1GB	2GB	4GB	8GB	16GB	32GB	64GB
105 0000	Sequential Read	60	110	110	110	110	110	110
ICF 9000	Sequential Write	25	50	50	90	70	100	100

- Operating temperature range:

Standard Grade: 0°C ~ +70°CIndustrial Grade: -40°C ~ +85°C

• Storage temperature range: -55°C ~ +95°C



3. Pin Assignment

See Table 1 for iCF9000 pin assignments.

Table 1: iCF9000 Pin Assignments

	True IDE Mode							
Pin No.	Name	I/O	Pin No.	Name	I/O			
1	GND		29	D13 ¹	I/O			
2	D03	I/O	30	D14 ¹	I/O			
3	D04	I/O	31	D15 ¹	I/O			
4	D05	I/O	32	-CS1 ¹	I			
5	D06	I/O	33	-VS1	GND			
6	D07	I/O						
7	-CS0	I	34	-IORD ⁷	I			
8	A10 ²	GND						
9	-ATA SEL	GND	25	-IOWR ⁷	I			
10	A09 ²	GND	35	-10VVR	1			
11	A08 ²	GND	36	-WE ³	I			
12	A07 ²	GND	37	INTRQ	0			
13	VCC	GND	38	VCC				
14	A06 ²	GND	39	-CSEL	I			
15	A05 ²	GND	40	-VS2	NC			
16	A04 ²	GND	41	-RESET	I			
17	A03 ²	GND						
18	A02	I	42	IORDY ¹	О			
19	A01	I						
20	A00	I	43	DMARQ	0			
21	D00	I/O	44	-DMACK ⁶	I			
22	D01	I/O	45	-DASP	I/O			
23	D02	I/O	46	-PDIAG	I/O			
24	-IOCS16	NC	47	D08 ¹	I/O			
25	-CD2	GND	48	D09 ¹	I/O			
26	-CD1	GND	49	D10 ¹	I/O			
27	D11 ¹	I/O	50	GND				
28	D12 ¹	I/O						

Note:

- 1) These signals are required only for 16 bit accesses and not required when installed in 8 bit systems. Devices should allow for 1-state signals not to consume current.
- 2) The signal should be grounded by the host.
- 3) The signal should be tied to VCC by the host.
- 4) The mode is optional for CF+ Cards, but required for CompactFlash® Storage Cards.
- 5) The –CSEL signal is ignored by the card in PC Card modes. However, because it is not pulled up on the card in these modes, it should not be left floating by the host in PC Card modes. In these modes, the pin should be connected by the host to PC Card A25 or grounded by the host.
- 6) If DMA operations are not used, the signal should be held high or tied to VCC by the host. For proper operation in older hosts: while DMA operations are not active, the card shall ignore this signal, including a floating condition
- 7) Signal usage in True IDE Mode except when Ultra DMA mode protocol is active.
- 8) Signal usage in True IDE Mode when Ultra DMA mode protocol DMA Write is active.
- 9) Signal usage in True IDE Mode when Ultra DMA mode protocol DMA Read is active.



4. Pin Description

Table 2 describes the pin descriptions for iCF9000

Table 2: iCF9000 Pin Description

Pin No.	Pin Name	I/O	Mode	Description
18,19,20	A2 - A0	I	True IDE Mode	In True IDE Mode, only A[2:0] are used to select the one of eight registers in the Task File, the remaining address lines should be grounded by the host.
46	-PDIAG	I/O	True IDE Mode	In the True IDE Mode, this input / output is the Pass Diagnostic signal in the Master / Slave handshake protocol.
45	-DASP	I/O	True IDE Mode	In the True IDE Mode, this input/output is the Disk Active/Slave Present signal in the Master/Slave handshake protocol.
26, 25	-CD1, -CD2	0	True IDE Mode	This signal is the same for all modes.
7, 32	-CS0, -CS1	I	True IDE Mode	In the True IDE Mode, -CS0 is the chip select for the task file registers while -CS1 is used to select the Alternate Status Register and the Device Control Register. While -DMACK is asserted, -CS0 and -CS1 shall be held negated and the width of the transfers shall be 16 bits.
39	-CSEL	I	True IDE Mode	This internally pulled up signal is used to configure this device as a Master or a Slave when configured in the True IDE Mode. When this pin is grounded, this device is configured as a Master. When the pin is open, this device is configured as a Slave.
2,3,4,5,63 1,30,29,2 8,27,49,4 8,47,23,2 2,21	D15 - D00	I/O	True IDE Mode	In True IDE Mode, all Task File operations occur in byte mode on the low order bus D[7:0] while all data transfers are 16 bit using D[15:0].
1, 50	GND	-	True IDE Mode	This signal is the same for all modes.



43	DMARQ	Ο	True IDE Mode	This signal is a DMA Request that is used for DMA data transfers between host and device. It shall be asserted by the device when it is ready to transfer data to or from the host. For Multiword DMA transfers, the direction of data transfer is controlled by –IORD and –IOWR. This signal is used in a handshake manner with –DMACK, i.e., the device shall wait until the host asserts –DMACK before negating DMARQ, and reasserting DMARQ if there is more data to transfer. DMARQ shall not be driven when the device is not selected. While a DMA operation is in progress, -CSO and -CS1 shall be held negated and the width of the transfers shall be 16 bits. If there is no hardware support for DMA mode in the host, this output signal is not used and should not be connected at the host. In this case, the BIOS must report that DMA mode is not supported by the host so that device drivers will not attempt DMA mode.
	-IORD		True IDE Mode	In True IDE Mode, while Ultra DMA mode is not active, this signal has the same function as in PC Card I/O Mode.
34	-HDMARDY	I		In True IDE Mode when Ultra DMA mode DMA Read is active, this signal is asserted by the host to indicate that the host is read to receive Ultra DMA data-in bursts. The host may negate -HDMARDY to pause an Ultra DMA transfer.
	HSTROBE			In True IDE Mode when Ultra DMA mode DMA Write is active, this signal is the data out strobe generated by the host. Both the rising and falling edge of HSTROBE cause data to be latched by the device. The host may stop generating HSTROBE edges to pause an Ultra DMA data-out burst.
35	-IOWR	I	True IDE Mode	In True IDE Mode, while Ultra DMA mode protocol is not active, this signal has the same function as in PC Card I/O Mode. When Ultra DMA mode protocol is supported, this signal must be negated before entering Ultra DMA mode protocol.



	STOP			In True IDE Mode, while Ultra DMA mode protocol is active, the assertion of this signal causes the termination of the Ultra DMA burst.
9	-ATA SEL	I	True IDE Mode	To enable True IDE Mode this input should be grounded by the host.
37	INTRQ	0	True IDE Mode	In True IDE Mode signal is the active high Interrupt Request to the host.
44	-DMACK	I	True IDE Mode	This is a DMA Acknowledge signal that is asserted by the host in response to DMARQ to initiate DMA transfers. While DMA operations are not active, the card shall ignore the -DMACK signal, including a floating condition. If DMA operation is not supported by a True IDE Mode only host, this signal should be driven high or connected to VCC by the host.
41	-RESET	I	True IDE Mode	In the True IDE Mode, this input pin is the active low hardware reset from the host.
13, 38	VCC	-	True IDE Mode	This signal is the same for all modes.
33, 40	-VS1, -VS2	0	True IDE Mode	This signal is the same for all modes.
	IORDY			In True IDE Mode, except in Ultra DMA modes, this output signal may be used as IORDY.
42	-DDMARDY		True IDE	In True IDE Mode, when Ultra DMA mode DMA Write is active, this signal is asserted by the host to indicate that the device is read to receive Ultra DMA data-in bursts. The device may negate -DDMARDY to pause an Ultra DMA transfer.
	DSTROBE			In True IDE Mode, when Ultra DMA mode DMA Write is active, this signal is the data out strobe generated by the device. Both the rising and falling edge of DSTROBE cause data to be latched by the host. The device may stop generating DSTROBE edges to pause an Ultra DMA data-out burst.



36	-WE	I	True IDE Mode	In True IDE Mode, this input signal is not used and should be connected to VCC by the host.
24	-IOCS16	0	True IDE Mode	In True IDE Mode this output signal is asserted low when this device is expecting a word data transfer cycle.



5. Specifications

5.1 CE and FCC Compatibility

iCF 9000 conforms to CE and FCC requirements.

5.2 RoHS Compliance

iCF 9000 is fully compliant with RoHS directive.

5.3 Environmental Specifications

5.3.1 Temperature Ranges

Operating Temperature Range:

- Standard Grade: 0°C to +70°C

- Industrial Grade: -40°C to +85°C

Storage Temperature Range: -55°C to +95°C

5.3.2 Humidity

Relative Humidity: 10-95%, non-condensing

5.3.3 Shock and Vibration

Table 3: Shock/Vibration Test for ICF9000

Reliability	Test Conditions	Reference Standards				
Vibration	7 Hz to 2 KHz, 20G, 3 axes	IEC 68-2-6				
Mechanical Shock	Duration: 0.5ms, 1500G, 3	IEC 68-2-27				
Prechanical Shock	axes	ILC 00-2-27				

5.3.4 Mean Time between Failures (MTBF)

Table 4 summarizes the MTBF prediction results for various ICF9000 configurations. The analysis was performed using a RAM Commander™ failure rate prediction.

- **Failure Rate**: The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- Mean Time between Failures (MTBF): A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.



Table 4: iCF9000 MTBF

Product	Condition	MTBF (Hours)
ICF9000	Telcordia SR-332 GB, 25°C	3,000,000

5.3.5 Write Protect Function Support

Innodisk CF card within the write-protect function could prevent the CF card from modification and deletion. Write-protected data in CF card could only be read, that is, users could not write to it, edit it, append data to it, or delete it.

When users would like to make sure that neither themselves nor others could modify or destroy the file, users could switch on write-protection. Thus Innodisk CF card would process write-protect mechanism and disable flash memory to be written-in any data. Only while the system power-off, users could switch on write-protection. Write-protection could not be switched-on, after OS booting.

5.3.6 Wear-Leveling

Flash memory can be erased a limited number of times. This number is called the *erase cycle limit* or *write endurance limit* and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

ICF9000 uses a wear-leveling algorithm to ensure that consecutive writes of a specific sector are not written physically to the same page in the flash. This spreads flash media usage evenly across all pages, thereby maximizing flash lifetime.



5.3.7 Reliability

Parameter	Value
Read Cycles	Unlimited Read Cycles
Wear-Leveling Algorithm	Support
Bad Blocks Management	Support
Error Correct Code	Support
TBW(Sequential Write)	
1GB	65.1 (Sequential write)
2GB	130.20 (Sequential write)
4GB	260.41 (Sequential write)
8GB	520.83 (Sequential write)
16GB	1041.66 (Sequential write)
32GB	2083.33 (Sequential write)
64GB	4166.66 (Sequential write)

5.4 Mechanical Dimensions

Mechanical Dimension: $42.80\pm0.1/36.40\pm0.1/3.30\pm0.05$ mm (W/T/H)

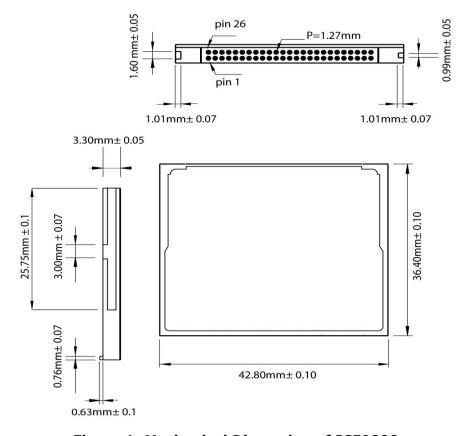


Figure 1: Mechanical Dimension of ICF9000

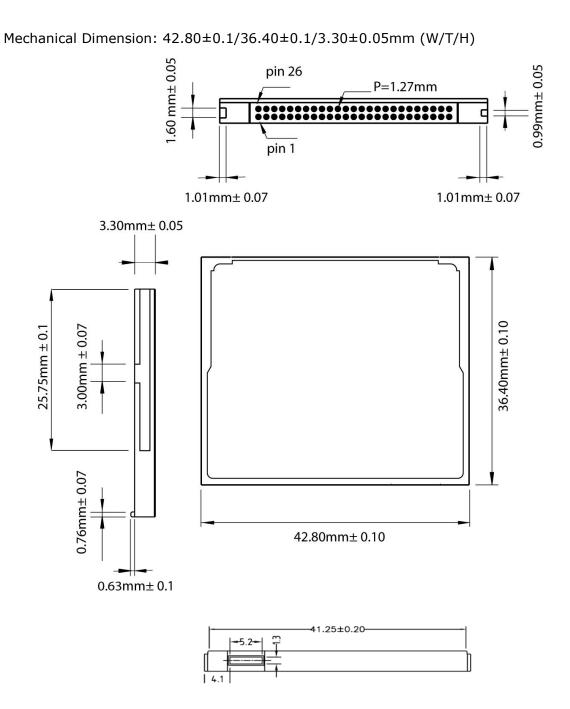


Figure 2: Mechanical Dimension of ICF9000 write protect



5.5 Electrical Specifications

5.5.1 DC Characteristic

Power supply requirement: 5V±0.5V DC or 3.3V±0.3V

5.5.2 Timing Specifications

5.5.2.1 True IDE PIO Mode Read/Write Timing Specification

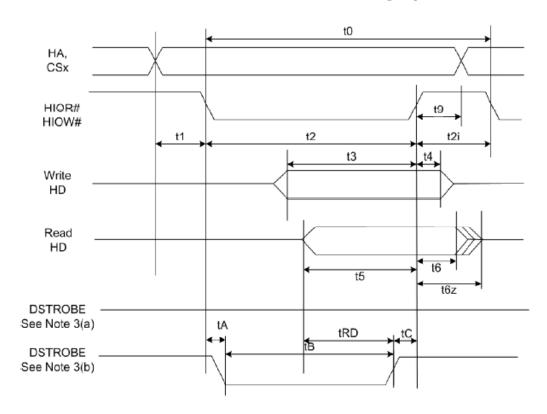


Figure 2: Read/Write Timing Diagram, PIO Mode

Note:

- 1. Device address comprises CS1#, CS0#, and HA[2:0].
- 2. Data comprises HD[15:0] (16-bit) or HD[7:0] (8-bit).
- 3. The negation of DSTROBE by the device is used to lengthen the PIO cycle. Whether the cycle is to be extended is determined by the host after Ta from the assertion of HIOR# or HIOW#. The assertion and negation of DSTROBE is described in the following three cases. (a) The device never negates DSTROBE: No wait is generated. (b) Device drives DSTROBE low before Ta: a wait is generated. The cycle is completed after DSTROBE is reasserted. For cycles in which a wait is generated and HIOR# is asserted, the device places read data on D15-D00 for Trd before DSTROBE is asserted.



Table 5: True IDE PIO Mode Read/Write Timing

PIC) timing parameters	Mode 0	Mode 1	Mode 2	Mode 3	Mode 4
t ₀	Cycle time (min.)	600	383	240	180	120
t ₁	Address valid to HIOR-/HIOW-setup (min.)	70	50	30	30	25
t ₂	HIOR-/HIOW- 16-bit (min.)	165	125	100	80	70
t ₂	HIOR-/HIOW- Register 8-bit (min.)	290	290	290	80	70
t _{2i}	HIOR-/HIOW- recovery time (min.)	-	-	-	70	25
t ₃	HIOW- data setup (min.)	60	45	30	30	20
t ₄	HIOW- data hold (min.)	30	20	15	10	10
t 5	HIOR- data setup (min.)	50	35	20	20	20
t ₆	HIOR- data hold (min.)	5	5	5	5	5
t _{6z}	HIOR- data tri-state (max.)	30	30	30	30	30
t ₉	HIOR-/HIOW- to address valid hold	20	15	10	10	10
t _R	Read data valid to IORDY active	0	0	0	0	0
D	(min.)	U	U	U	U	U
t _A	IORDY setup time	35	35	35	35	35
t _B	IORDY pulse width (max.)	1250	1250	1250	1250	1250
tc	IORDY assertion to release (max.)	5	5	5	5	5



5.5.2.2 True IDE Multiword DMA Mode Read/Write Timing

Specification

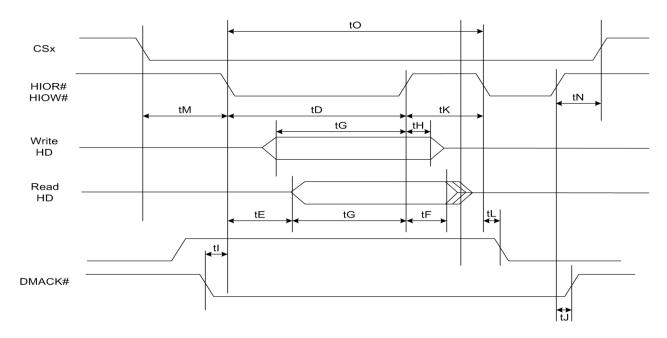


Figure 3: True IDE Multiword DMA Mode Read/Write Timing

Note:

- 1. If a card cannot sustain continuous, minimum cycle time DMA transfers, it may negate DMARQ during the time from the start of a DMA transfer cycle (to suspend DMA transfers in progress) and reassertion of the signal at a relatively later time to continue DMA transfer operations.
- 2. The host may negate this signal to suspend the DMA transfer in progress.

Table 6: True IDE Multiword DMA Read/Write Timing

Mult	tiword DMA timing parameters	Mode 0	Mode 1	Mode 2	
t ₀	Cycle time (min.)	480	150	120	
t _o	HIOR-/HIOW- assertion width	215	80	70	
t _D	(min.)	213	60	70	
t⊨	HIOR- data access (max.)	150	60	50	
t_{\scriptscriptstyleF}	HIOR- data hold (min.)	5	5	5	
t _G	HIOR-/HIOW- data setup (min.)	100	30	20	
tн	HIOW- data hold (min.)	20	15	10	
tī	DMACK to HIOR-/HIOW- setup	0	0	0	
CI	(min.)	U	U	U	
t ₁	HIOR-/HIOW- to DMACK hold	20	5	5	
U	(min.)	20	,	5	



t _{KR}	HIOR- negated width (min.)	50	50	25
tĸw	HIOW- negated width (min.)	215	50	25
t _{LR}	HIOR- to DMARQ delay (max.)	120	40	35
t_LW	HIOW- to DMARQ delay (max.)	40	40	35
tм	CS1-, CS0- valid to HIOR-/HIOW-	50	30	25
t _N	CS1-, CS0- hold	15	10	10

5.5.2.3 True IDE Ultra DMA Mode Data Burst Timing Specification

Table 7: Timing Diagram, Ultra DMA Mode 0-6

Illtra DMA timina		Mod	e 0	Mode 1		Mod	Mode 2		Mode 3		e 4	Mode 5		Mode 6	
	Ultra DMA timing parameters		Max	Min.	Max	Min.	Min.	Max	Min.	Max	Max	Max	Min.	Max	Max
t _{2CYC}	Typical sustained average two cycle time	240	-	160	-	90	-	60	-	60	-	40	-	30	-
tcyc	Cycle time allowing for asymmetry and clock variations (from STROBE edge to STROBE edge)	112	-	73	-	39	-	25	-	25	-	16. 8	-	13	-
tzcyc	Two cycle time allowing for clock variations (from rising edge to next rising edge or from falling edge to next falling edge of STROBE)	230	-	153	-	86	-	57	-	57	-	38	-	29	-
t _{DS}	Data setup time (at recipient)	15	-	10	-	7	-	5	-	5	-	4	-	2.6	-
t DH	Data hold time (at recipient)	5	_	5	ı	5	ı	5	-	5	_	4.6	-	3.5	-
t _{DVS}	Data valid setup time at sender (from data bus being valid until STROBE edge)	70	-	48	-	20	-	6.7	-	6.7	-	4.8	-	4	-
t _{DVH}	Data valid hold time	6.2	-	6.2	-	6.2	-	6.2	-	6.2	-	4.8	-	4	-



	at sender (from STROBE edge until data may become invalid)														
tu	Limited interlock time	0	150	0	150	0	100	0	100	0	100	0	75	0	60
t _{MLI}	Interlock time with	20	-	20	-	20	-	20	-	20	-	20	-	20	-
tuɪ	Unlimited interlock time	0	-	0	-	0	-	0	-	0	-	0	-	0	-
taz	Maximum time allowed for output drivers to release (from being asserted or negated)	-	10	-	10	-	10	-	10	-	10	-	10	-	10
t _{ZAH}	Minimum delay time	20	-	20	-	20	1	20	-	20	-	20	-	20	-
t _{ZAD}	required for output drivers to assert or negate (from released state)	0	-	0	-	0	-	0	-	0	-	0	-	0	-
t _{ENV}	Envelope time (from DMACK- to STOP and HDMARDY- during data out burst initiation)	20	70	20	70	20	55	20	55	20	55	20	50	20	50
t _{RFS}	Ready-to-final-STRO BE time (no STROBE edges shall be sent this long after negation of DMARDY-)	-	75	-	70	-	60	-	60	-	60	-	50	-	50
t _{RP}	Ready-to-pause time (time that recipient shall wait to initiate pause after negating DMARDY-)	160	-	125	-	100	-	100	-	100	-	85	-	85	-
t _{IORD}	Pull-up time before allowing IORDY to be	-	20	-	20	-	20	-	20	-	20	-	20	-	20



	released														
tzior DY	Minimum time device shall wait before driving IORDY	0	-	0	-	0	-	0	-	0	1	0	-	0	1
t ack	Setup and hold times for DMACK- (before assertion or negation)	20	-	20	-	20	-	20	-	20	-	20	-	20	1
tss	Time from STROBE edge to negation of DMARQ or assertion of STOP (when sender terminates a burst)	50		50	-	50	-	50	-	50	-	50	-	50	1
tғs	First STROBE time (for device to first negate DSTROBE from STOP during a data in burst)	-	230	-	200	-	130	-	120	-	120	-	90	-	80

5.6 Transfer Function

5.6.1 True IDE Mode I/O Transfer Function

The ICF9000 can be configured in a True IDE Mode of operation. The ICF9000 is configured in this mode only when –OE input signal is grounded by the host during the power off to power on cycle.

Table 8: True IDE Mode I/O Function

Function Code	-CS1	-CS0	-A0∼A2	-DMACK	-IORD	-IOWR	D15~D8	D7~D0
	L	L	X	Х	X	Х	Undefined	Undefined
							In/Out	In/Out
	L	Х	X	L	L	Х	Undefined	Undefined
							Out	Out
Invalid Mode	L	Х	Х	L	Х	L	Undefined	Undefined
Invalid Mode							In	In
	X	L	X	L	L	Х	Undefined	Undefined
							Out	Out
	X	L	X	L	X	L	Undefined	Undefined
							In	In
Standby Mode	Н	Н	Х	Н	X	Х	High Z	High Z



Task File Write	Н	L	1-7h	Н	Н	L	Don't Care	Data In
Task File Read	Н	L	1-7h	Н	L	Н	High Z	Data In
PIO Data Register	Н	L	0	Н	Н	L	Odd-Byte	Even-Byte
Write							In	In
DMA Data	Н	Н	Х	L	Н	L	Odd-Byte	Even-Byte
Register Write							In	In
Ultra DMA Data	Н	Н	Х	L	See Note	e 1	Odd-Byte	Even-Byte
Register Write							In	In
PIO Data Register	Н	L	0	Н	L	Н	Odd-Byte	Even-Byte
Read							Out	Out
DMA Data	Н	Н	Х	L	L	Н	Odd-Byte	Even-Byte
Register Read							Out	Out
Ultra DMA Data	Н	Н	Х	L	See Note	e 2	Odd-Byte	Even-Byte
Register Read							Out	Out
Control Register	L	Н	6h	Н	Н	L	Don't Care	Control In
Write								
Alt Status Read	L	Н	6h	Н	L	Н	High Z	Status Out
Drive Address	L	Н	7h	Н	L	Н	High Z	Data Out

Note1: In Ultra DMA Data Register Write mode the signals –IORD, -IOWR and IORDY are redefined and used as follows: -IORD as HSTROBE, -IOWR as STOP and IORDY as –DDMARDY. Data transfers with each edge of HSTROBE.

Note2: In Ultra DMA Data Register Read mode the signals –IORD, -IOWR and IORDY are redefined and used as follows: -IORD as –HDMARDY H, -IOWR as STOP and IORDY as DSTROBE. Data transfer with each edge of DSTROBE.

5.7 Configuration Register

5.7.1 Configuration Option Register (200h in Attribute Memory)

The Configuration Option Register is used to configure the cards interface, address decoding and interrupt and to issue a soft reset to the ICF9000.

Table 9: Configuration Option Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
R/W	SRESET	LevelREQ	Conf5	Conf4	Conf3	Conf2	Conf1	Conf0

Table 10: Information for Configuration Option Register



Name	Description
SRSET	Soft Reset: Setting this bit to one (1), waiting the minimum reset time and
	returning to zero(0) places the ICF9000 in the reset state. Setting this bit to
	one (1) is equivalent to assertion of the +RESET signal except that the
	SRESET bit is not cleared. Returning this bit to zero (0) leaves the ICF9000
	in the same un-configured, Reset state as following power-up and hardware
	reset. Contrast with Soft Reset in the Device Control Register.
LevelREQ	This bit is set to one (1) then Level Mode Interrupt is selected, and zero (0)
	then Pulse Mode is selected. Set to zero (0) by Reset.
Conf5-0	Configuration Index: Set to zero (0) by reset. It is used to select operation
	mode of the ICF9000 as shown below

Note: Conf5 and Conf4 are reserved for CompactFlash Storage cards and shall be written as zero(0).

5.7.2 Pin Replacement register (204h in Attribute Memory)

Table 11: Pin Replacement Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
Read	0	0	Cready	0	1	1	Rready	0
Write	0	0	Cready	0	0	0	Mready	0

Table 12: Information for Pin Replacement Register

Name	Description
Cready	This bit is set to one (1) when the bit Rready changes state. This bit
	can also be written by the host.
Rready	This bit is used to determine the internal state of the READY signal.
	This bit may be used to determine the state of the READY signal as
	this pin has been reallocated for use as Interrupt Request on an I/O
	card. When written, this bit acts as a mask (Mready) for writing the
	corresponding bit Cready.
Mready	This bit acts as a mask for writing corresponding bit Cready.

5.7.3 Socket and Copy Register (206h in Attribute Memory)

This register contains additional configuration information. This register is always written by the system before writing the card's Configuration Index Register. This register is used for identification of the card from the other card.

Table 13: Socket and Copy Register

Operation	D7	D6	D5	D4	D3	D2	D1	D0
Read	0	0	0	Obsolete	0	0	0	0



				(Drive #)				
Write	0	0	0	Obsolete	X	X	Х	Х
				(Drive #)				

Table 14: Information for Socket and Copy Register

Name	Description
Obsolete(Drive #)	This bit is obsolete and should be written as 0.

5.8 Software Interface

5.8.1 True IDE Mode Addressing

When the ICF9000 is configured in the True IDE mode, the I/O decoding is as follows:

Table 15: True IDE Mode I/O Decoding

-CS1	-CS0	A2	A1	Α0	-DMACK	-IORD=0	-IOWR=0	Note
1	0	0	0	0	1	PIO RD Data	PIO WR Data	8 or
1	1	Χ	Χ	Χ	0	DMA RD Data	DMA WR Data	16 bit
1	0	0	0	1	1	Error Register	Features	8 bit
1	0	0	1	0	1	Sector Count Sector Count		8 bit
1	0	0	1	1	1	Sector No.	Sector No.	8 bit
1	0	1	0	0	1	Cylinder Low	Cylinder Low	8 bit
1	0	1	0	1	1	Cylinder High	Cylinder High	8 bit
1	0	1	1	0	1	Select Card/Head Select Card/Head		8 bit
1	1	1	1	1	1	Status Command		8 bit
0	1	1	1	0	1	Alt Status	Device Control	8 bit

5.8.2 CF-ATA Register

The following section describes the hardware registers used by the host software to issue commands to the ICF9000.

Note:

In True IDE Mode of operation, the size of the transfer is based solely on the register being addressed. All registers are 8 bit only except for the Data Register, which is normally 16 bits, but can be programmed to use 8 bit transfers for Non-DMA operations through the use of the Set Features command. The data register is also 8 bits during a portion of the Read Long and Write Long commands, which exist solely for historical reasons and should not be used.



5.8.2.1 Data Register

The Data Register is a 16 bit register, and it is used to transfer data blocks between the card and the host. This register overlaps the Error Register. This register can be accessed in word and byte mode.

Table 16: Data Register

Data	Registe	er													
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

5.8.2.2 Error Register

This register contains additional information about the source of an error when an error is indicated in bit 0 of the Status register. The bits are defined as follows.

Table 17: Error Register

BBK	UNC	0	IDNF	0	ABRT	0	AMNF
D7	D6	D5	D4	D3	D2	D1	D0

5.8.2.3 Feature Register

This register provides information regarding features of the card that the host can utilize. This register is also accessed in PC Card modes on data D15-D8 during a write operation to Offset 0 with -CE2 low and -CE1 high.

Table 18: Feature Register

Feature Re	Feature Register										
D7	D6	D5	D4	D3	D2	D1	D0				

5.8.2.4 Sector Count Register

This registers the number of sectors of data requested to be transferred on a read or write operation between the host and the card. If the value in this register is zero, a count of 256 sectors is specified. If the command was successful, this register is zero at command completion. If not successfully completed, the register contains the number of sectors that need to be transferred in order to complete the request.

Table 19: Sector Count Register

Sector Cou	unt Register						
D7	D6	D5	D4	D3	D2	D1	D0

5.8.2.5 **Sector Number Register**

This register contains the starting sector number or bits 7-0 of the Logical Block Address



(LBA) for ICF9000 data access for the subsequent command.

Table 20: Sector Number Register

Sector Number Register								
D7	D6	D5	D4	D3	D2	D1	D0	

5.8.2.6 Cylinder Low Register

This Register contains the low order 8 bits of the starting cylinder address or bits 15-8 of the Logical Block Address.

Table 21: Cylinder Low Register

Cylinder L	ow Register						
D7	D6	D5	D4	D3	D2	D1	D0

5.8.2.7 Cylinder High Register

This Register contains the high order 8 bits of the starting cylinder address or bits 23-16 of the Logical Block Address.

Table 22: Cylinder High Register

C	Cylinder H	igh Register	-					
	07	D6	D5	D4	D3	D2	D1	D0

5.8.2.8 Device/Head Register

The Drive/Head register is used to select the drive and head. It is also used to select LBA addressing instead of cylinder/head/sector addressing.

Table 23: Device/Head Register

1	LBA	1	DRV	HS3	HS2	HS1	HS0
D7	D6	D5	D4	D3	D2	D1	D0

Bit7: this bit is set 1.

Bit6: LBA is a flag to select either Cylinder/Head/Sector or Logical Block Address mode. When LBA=0, Cylinder/Head/Sector mode is selected. When LBA=1, Logical Block Address is selected.

Bit5: this bit is set 1.

Bit4: DRV is the drive number. When DRV=0, drive (card) 0 is selected. When DRV=1, drive (card) 1 is selected.

Bit3: When operation in the Cylinder/Head/Sector mode, this is bit 3 of the head number.



It is bit 27 in the Logical Block Address mode.

Bit2: When operation in the Cylinder/Head/Sector mode, this is bit 2 of the head number. It is bit 26 in the Logical Block Address mode.

Bit1: When operation in the Cylinder/Head/Sector mode, this is bit 1 of the head number. It is bit 25 in the Logical Block Address mode.

Bit0: When operation in the Cylinder/Head/Sector mode, this is bit 0 of the head number. It is bit 24 in the Logical Block Address mode.

5.8.2.9 Status Register

These registers return the ICF9000 status when read by the host. Reading the Status register does clear a pending interrupt while reading the Auxiliary Status register does not.

Table 24: Status Register

BUSY	RDY	DWF	DSC	DRQ	CORR	0	ERR
D7	D6	D5	D4	D3	D2	D1	D0

Bit7: the busy bit is set when the ICF9000 has access to the command buffer and registers and the host is locked out from accessing the command register and buffer. No other bits in this register are valid when this bit set to a 1.

Bit6: RDY indicates whether the device is capable of performing ICF9000 operations. This bit is cleared at power up and remains cleared until the card is ready to accept a command.

Bit5: This bit, if set, indicates a write fault has occurred.

Bit4: This bit is set when the ICF9000 is ready.

Bit3: The Data Request is set when the ICF9000 requires that information be transferred either to or from the host through the Data register.

During the data transfer of DMA commands, the card shall not asserted DMARD unless either the BUST bit, the DRQ, or both are set to one.

Bit2: This bit is set when a Correctable data error has been encountered and the data has been corrected. This condition does not terminate a multi-sector read operation.

Bit1: This bit is always to 0.

Bit0: This bit is set when the previous command has ended in some type of error. The bits in the Error register contain additional information description the error.

5.8.2.10 Device Control Register

This register is used to control the ICF9000 interrupt request and to issue an ATA soft reset to the card. This register can be written even if the device is BUSY.



Table 25: Device Control Register

Χ	Х	X	X	Х	SW Rst	-Ien	0
D7	D6	D5	D4	D3	D2	D1	D0

Bit7-3: These bits are ignored.

Bit2: This bit is set to 1 in order to force the ICF9000 to perform a Soft Reset operation. The Card remains in Reset until this bit is reset to '0'.

Bit1: the Interrupt Enable bit enables interrupts when the bit is 0. When the bit is 1, interrupt from the ICF9000 are disabled. This bit also controls the Int bit in the Configuration and Status Register. This bit is set to 0 at power on and Reset.

Bit0: This bit is ignored.

5.8.2.11 Drive Address Register

This register is provide for compatibility with the AT disk drive interface.

Table 26: Drive Address Register

X	-WTG	-HS3	-HS2	-HS1	-HS0	-Nds1	-Nds0
D7	D6	D5	D4	D3	D2	D1	D0

Bit7: this bit is unknown.

Bit6: this bit is – when a write operation is in progress; otherwise, it is 1.

Bit5: this bit is the negation of bit 3 in the Drive/Head register.

Bit4: this bit is the negation of bit 2 in the Drive/Head register.

Bit3: this bit is the negation of bit 1 in the Drive/Head register.

Bit2: this bit is the negation of bit 0 in the Drive/Head register.

Bit1: this bit is 0 when drive 1 is active and selected.

Bit0: this bit is 0 when the drive 0 is active and selected.



5.9 Hardware Reset

Table 27: Timing Diagram, Hardware Reset

	Item	Min.	Max.	Normal	Unit
tsu(RESET)	Reset Setup	20	-	-	ms
	Time				
trec(VCC)	-CE Recover	1	-	-	us
	Time				
t _{PR}	VCC rising up	0.1	100	-	ms
	time				
t _{PF}	VCC falling	3	300	-	ms
	down time				
tw(RESET)	Reset pulse	10	-	-	ms
t _H (Hi-ZRESET)	width	0	-	-	
t _S (Hi-ZRESET)		0	-	-	

5.10 Power on Reset

When the VCC power reaches to 2.7V, the disk drive will be reset.

Table 28: Timing Diagram, Power On Reset

	Item	Min.	Max.	Normal	Unit	Note
tsu(RESET)	-CE Setup Time	20	-	-	ms	
t _{PR}	-VCC Rising Սլ	0.1	100	-	ms	
	Time					

Power on Reset Timing

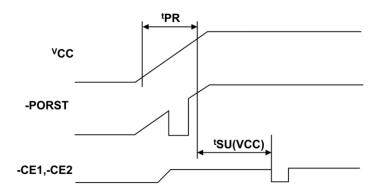




Figure 4: Timing Diagram, Power On Reset

5.11 Support IDE Commands

ICF9000 supports the commands listed in Table 29.

Table 29: IDE Commands

	Table 29. 1						
Command	Code	FR	sc	SN	CY	DH	LBA
Check Power Mode	E5H	-	-	-	-	D	-
Execute Device	90H	-	-	-	-	D	-
Diagnostic	9011						
Flush Cache	E7H	-	-	-	-	Υ	-
Identify Device	ECH	-	-	-	-	D	-
Idle	E3H	-	Υ	-	-	D	-
Idle immediate	E1H	-	-	-	-	D	-
Read Buffer	E4H	-	-	-	-	D	-
Read DMA	C8H	-	Υ	Υ	Υ	Υ	Υ
Read Sector(s)	20H	-	Υ	Υ	Υ	Υ	Υ
Read Verify Sector(s)	40H	-	Υ	Υ	Υ	Υ	Υ
Set Features	EFH	Υ	-	-	-	D	-
Set Multiple Mode	C6H	-	Υ	-	-	D	-
Set Sleep Mode	E6H	-	-	-	-	D	-
SMART	B0h	Υ	-	-	Υ	Υ	-
Standby	E2H	-	-	-	-	D	-
Standby Immediate	E0H	-	-	-	-	D	-
Write Buffer	E8H	-	-	-	-	D	-
Write DMA	CAH	-	Υ	Υ	Υ	Υ	Υ
Write Multiple	C5h	-	Υ	Υ	Υ	Υ	Υ
Write Sector(s)	30H	-	Υ	Υ	Υ	Υ	Υ

Defines:

FR: Feature Register

SC: Sector Count Register
SN: Sector Number Register

CY: Cylinder Registers

DH: Card/Device/Head Register

LBA: LBA Block Address Mode Supported

Y: The register contains a valid parameter for this command. For Card/Device/Head Register Y means both the CompactFlash Storage Card and head parameter are used; D – only the CompactFlash Storage Card parameter is valid and not the head parameter; C – The register contains command specific data (see command description for use).



5.11.1 Check power mode -E5h

Table 30: Check power mode information

Register	7	6	5	4	3	2	1	0
Command(7)	E5h							
C/D/H(6)	Χ			Drive	Χ			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	X							

This command checks the power mode. If the CompactFlash Storage is in, going to, or recovering from the sleep mode, the CompactFlash Storage Card sets BSY, sets the Sector Count Register to 00h, clears BSY and generates an interrupt. If the ompactFlash Storage Card is in idle mode, the CompactFlash Storage Card sets BSY, sets the Sector Count Register to FFh, clears BSY and generates an interrupt.

5.11.2 Execute Device Diagnostic - 90h

Table 31: Execute device diagnostic information

Register	7	6	5	4	3	2	1	0
Command(7)	90h							
C/D/H(6)	X			Drive	X			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	X							

This command performs the internal diagnostic tests implemented by the CompactFlash Storage Card. When the diagnostic command is issued in the True IDE Mode, the Drive bit is ignored and the diagnostic command is executed by both the Master and the Slave with the Master responding with status for both devices. The Diagnostic codes are shown in Table 34. Diagnostic Codes are returned in the Error Register at the end of the command.

Table 32: Diagnostic

Code	Error Type
------	------------



01h	No Error Detected
02h	Formatter Device Error
03h	Sector Buffer Error
04h	ECC Circuitry Error
05h	Controller Microprocessor Error
8Xh	Slave Error in True IDE Mode

5.11.3 Flush Cache- E7h

5.11.18.1 Command Code

E7h

5.11.18.2 Protocol

Non-data

5.11.18.3 Inputs

Table 33: Flush cache command for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na			
Command	E7h							

Device register-

DEV shall specify the selected device.

5.11.18.4 Normal Output

Table 34: Flush cache command for normal output information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device register-

DEV shall specify the selected device.

Status register



BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be cleared to zero.

DRQ will be cleared to zero

ERR will be cleared to zero.

5.11.18.5 Error Outputs

Table 35: Flush cache command for error output information

Register	7	6	5	4	3	2	1	0
Error	Na	Na	Na	Na	Na	ABRT	Na	Na
Sector Count	Na	Na						
LBA Low	LBA(7:	LBA(7:0)						
LBA Mid	LBA(1	LBA(15:8)						
LBA High	LBA(23	3:16)						
Device	Obs	Na	obs	DEV	LBA(27:24)			
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Error register-

ABRT may be set to one if the device is not able to complete the action requested by the command.

LBA Low, LBA Mid, and LBA High, Device

Shall be written with the address of first unrecoverable error.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be cleared to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.18.6 Prerequisites

DRDY will be set to one.

5.11.18.7 Description

This command is used by the host to request the device to flush the write cache. If there is data in write cache, that data shall be written to the SSD. The BSY bit shall remain set to one until all data has been successfully written or an error occurs.

5.11.4 Identify Device- Ech

Table 36: Identify device information

Register	7	6	5	4	3	2	1	0



Command(7)	Ech				
C/D/H(6)	Χ	Χ	Χ	Drive	X
Cylinder	Χ				
High(5)					
Cylinder Low(4)	Χ				
Sector	Χ				
Number(3)					
Sector Count(2)	Χ				
Feature(1)	Χ				

The Identify Device command enables the host to receive parameter information from the CompactFlash Storage Card. This command has the same protocol as the Read Sector(s) command. The parameter words in the buffer have the arrangement and meanings defined in Table 35. All reserved bits or words are zero. Hosts should not depend in Obsolete words in Identify Device containing 0. Table 35 specifies each filed in the data returned by the Identify Device Command. In Table 35, X indicates a numeric nibble vale specific to the card and aaaa indicates an ASCII string specific to the particular drive.

Table 37: IDENTIFY DEVICE information

Word	Description	Value
	General configuration bit-significant information:	
	15 0 = ATA device	
	14-8 Retired	
	7 1 = removable media device	
0	6 Obsolete	044Ah
	5-3 Retired	
	2 Response incomplete	
	1 Retired	
	0 Reserved	
1	Obsolete	XXXXh
2	Specific configuration	0000h
3	Obsolete	00XXh
4-5	Retired	XXXXh
6	Obsolete	XXXXh
7-8	Reserved for assignment by the CompactFlash™ Association	XXXXh
9	Retired	0000h
10-19	9 Serial number (20 ASCII characters)	
10 19		



20-21	Retired	0002h
22	Obsolete	0004h
22.26		8 ASCII
23-26	Firmware revision (8 ASCII characters)	characters
27.46	M (40 ACCT)	40 ASCII
27-46	Model number (40 ASCII characters)	characters
	15-8 80h	
47	7-0 00h = Reserved	8001h
47	01h-FFh = Maximum number of sectors that shall be transferred per interrupt	000111
	on READ/WRITE MULTIPLE commands	
48	Reserved	0000h
	Capabilities	
	15-14 Reserved for the IDENTIFY PACKET DEVICE command.	
	13 1 = Standby timer values as specified in this standard are supported	
	0 = Standby timer values shall be managed by the device	
	12 Reserved for the IDENTIFY PACKET DEVICE command.	
49	11 1 = IORDY supported	0F00h
	0 = IORDY may be supported	
	10 1 = IORDY may be disabled	
	9 1 = LBA supported	
	8 1 = DMA supported.	
	7-0 Retired	
	Capabilities	
	15 Shell be cleared to zero	
F0	14: Shall be set to one	0000h
50	13-2 Reserved	oooon
	1 Obsolete	
	0 Shall be set to one to indicate a device specific Standby timer value minimum.	
51	Obsolete	0200h
52	Obsolete	0000h
	15-3 Reserved	
	2 1 = the fields reported in word 88 are valid Reserved	
53	0 = the fields reported in word 88 are not valid	0007h
	1 1 = the fields reported in words (70:64) are valid	0007N
	0 = the fields reported in words (70:64) are not valid	
	0 Obsolete	
54	Number of current logical cylinders	XXXXh



55	Number of current logical heads	XXXXh
56	Number of current logical sectors per logical track	XXXXh
57-58	Current capacity in sectors	XXXXh
59	15-9 Reserved 8 1 = Multiple sector setting is valid 7-0 xxh = Current setting for number of sectors that shall be transferred per interrupt on R/W Multiple command	01XXh
60-61	Total number of user addressable sectors	XXXXXXXX
62	Obsolete	0000h
63	15-11 Reserved 10 1 = Multiword DMA mode 2 is selected 0 = Multiword DMA mode 2 is not selected 9 1 = Multiword DMA mode 1 is selected 0 = Multiword DMA mode 1 is not selected 8 1 = Multiword DMA mode 0 is selected 0 = Multiword DMA mode 0 is not selected 7-3 Reserved 2 1 = Multiword DMA mode 2 and below are supported 1 1 = Multiword DMA mode 1 and below are supported 0 1 = Multiword DMA mode 0 is supported	XX07h
64	15-8 Reserved 7-0 PIO modes supported	0003h
65	Minimum Multiword DMA transfer cycle time per word 15-0 Cycle time in nanoseconds	0078h
66	Manufacturer's recommended Multiword DMA transfer cycle time 15-0 Cycle time in nanoseconds	0078h
67	Minimum PIO transfer cycle time without flow control 15-0 Cycle time in nanoseconds	0078h
68	Minimum PIO transfer cycle time with IORDY flow control 15-0 Cycle time in nanoseconds	0078h
69-70	Reserved (for future command overlap and queuing)	0000h
71-74	Reserved for the IDENTIFY PACKET DEVICE command.	0000h
75	Queue depth 15-5 Reserved 4-0 Maximum queue depth – 1	0000h
76-79	Reserved for Serial ATA	0000h 0000h



		0000h
		0000h
	Major version number	
	0000h or FFFFh = device does not report version	
	15 Reserved	
	14 Reserved for ATA/ATAPI-14	
	13 Reserved for ATA/ATAPI-13	
	12 Reserved for ATA/ATAPI-12	
	11 Reserved for ATA/ATAPI-11	
	10 Reserved for ATA/ATAPI-10	
80	9 Reserved for ATA/ATAPI-9	0080h
80	8 Reserved for ATA/ATAPI-8	008011
	7 1 = supports ATA/ATAPI-7	
	6 1 = supports ATA/ATAPI-6	
	5 1 = supports ATA/ATAPI-5	
	4 1 = supports ATA/ATAPI-4	
	3 Obsolete	
	2 Obsolete	
	1 Obsolete	
	0 Reserved	
	Minor version number	
81	0000h or FFFFh = device does not report version	0000h
	0001h-FFFEh = See 6.17.41	
	Command set supported.	
	15 Obsolete	
	14 1 = NOP command supported	
	13 1 = READ BUFFER command supported	
	12 1 = WRITE BUFFER command supported	
	11 Obsolete	
82	10 1 = Host Protected Area feature set supported	742Bh
	9 1 = DEVICE RESET command supported	
	8 1 = SERVICE interrupt supported	
	7 1 = release interrupt supported	
	6 1 = look-ahead supported	
	5 1 = write cache supported	
	Shall be cleared to zero to indicate that the PACKET Command feature set is 4	
	not supported.	



	3	1 = mandatory Power Management feature set supported	
	2	1 = Removable Media feature set supported	
	1	1 = Security Mode feature set supported	
	0	1 = SMART feature set supported	
	Comma	and sets supported.	
	15	Shall be cleared to zero	
	14	Shall be set to one	
	13	1 = FLUSH CACHE EXT command supported	
	12	1 = mandatory FLUSH CACHE command supported	
	11	1 = Device Configuration Overlay feature set supported	
	10	1 = 48-bit Address feature set supported	
	9	1 = Automatic Acoustic Management feature set supported	
83	8	1 = SET MAX security extension supported	5100h
	7	See Address Offset Reserved Area Boot, INCITS TR27:2001	
	6	1 = SET FEATURES subcommand required to spinup after power-up	
	5	1 = Power-Up In Standby feature set supported	
	4	1 = Removable Media Status Notification feature set supported	
	3	1 = Advanced Power Management feature set supported	
	2	1 = CFA feature set supported	
	1	1 = READ/WRITE DMA QUEUED supported	
	0	1 = DOWNLOAD MICROCODE command supported	
	Comma	and set/feature supported extension	
	15	Shall be cleared to zero	
·	14	Shall be set to one	
	13	1 = IDLE IMMEDIATE with UNLOAD FEATURE supported	
	12	Reserved for technical report	
	11	Reserved for technical report	
	10	$1 = URG\ bit\ supported\ for\ WRITE\ STREAM\ DMA\ EXT\ and\ WRITE\ STREAM\ EXT$	
84	9	$1 = URG\ bit\ supported\ for\ READ\ STREAM\ DMA\ EXT\ and\ READ\ STREAM\ EXT$	4003h
	8	1 = 64-bit World wide name supported	
	7	1 = WRITE DMA QUEUED FUA EXT command supported	
	6	1 = WRITE DMA FUA EXT and WRITE MULTIPLE FUA EXT commands	
		supported	
	5	1 = General Purpose Logging feature set supported	
	4	1 = Streaming feature set supported	
	3	1 = Media Card Pass Through Command feature set supported	



	2 1 = Media serial number supported	
	1 1 = SMART self-test supported	
	0 1 = SMART error logging supported	
	Command and feature sets supported or enabled	
	15 Obsolete	0
	14 1 = NOP command enabled	0
	13 1 = READ BUFFER command enabled	0
	12 1 = WRITE BUFFER command enabled	0
	11 Obsolete	0
	10 1 = Host Protected Area feature set enabled	1
	9 1 = DEVICE RESET command enabled	0
	8 1 = SERVICE interrupt enabled	
85	2 SERVICE Interrupt chables	0
	7 1 = release interrupt enabled	0
	6 1 = look-ahead enabled	0
	5 1 = Write Cache enabled	1
	4 Shall be cleared to zero to indicate that the PACKET Command feature set is	0
	not supported.	
	3 1 = Power Management feature set enabled	0
	2 1 = Removable Media feature set enabled	0
	1 1 = Security Mode feature set enabled	X
	0 1 = SMART feature set enabled	Х
	Command set/feature enabled	
	15-14 0 = Reserved	
	13 1 = FLUSH CACHE EXT command supported	
	12 1 = FLUSH CACHE command supported	
	11 1 = Device Configuration Overlay supported	
	10 1 = 48-bit Address features set supported	
	9 1 = Automatic Acoustic Management feature set enabled	
86	8 1 = SET MAX security extension enabled by SET MAX SET PASSWORD	1000h
	7 See Address Offset Reserved Area Boot, INCITS TR27:2001	
	6 1 = SET FEATURES subcommand required to spin-up after power-up	
	5 1 = Power-Up In Standby feature set enabled	
	4 1 = Removable Media Status Notification feature set enabled	
	3 1 = Advanced Power Management feature set enabled	
	2 1 = CFA feature set enabled	
	1 1 = READ/WRITE DMA QUEUED command supported	
	0 1 = DOWNLOAD MICROCODE command supported	



	Comm	and and feature sets supported or enabled						
	15	Shall be cleared to zero						
	14	Shall be set to one						
	13	1 = IDLE IMMEDIATE with UNLOAD FEATURE supported						
	12	Reserved for technical report-						
	11	Reserved for technical report-						
	10	1 = URG bit supported for WRITE STREAM DMA EXT and WRITE STREAM EXT						
	9	1 = URG bit supported for READ STREAM DMA EXT and READ STREAM EXT						
87	8	1 = 64 bit World wide name supported	0003h					
07	7	1 = WRITE DMA QUEUED FUA EXT command supported	000311					
	6	1 = WRITE DMA FUA EXT and WRITE MULTIPLE FUA EXT commands						
	5	1 = General Purpose Logging feature set supported						
	4							
	3 1 = Media Card Pass Through Command feature set enabled							
	2	1 = Media serial number is valid						
	1	1 = SMART self-test supported						
	0	1 = SMART error logging supported						
	15	Reserved						
	14	1 = Ultra DMA mode 6 is selected						
		0 = Ultra DMA mode 6 is not selected						
	13	1 = Ultra DMA mode 5 is selected						
		0 = Ultra DMA mode 5 is not selected						
	12	1 = Ultra DMA mode 4 is selected						
		0 = Ultra DMA mode 4 is not selected						
	11	1 = Ultra DMA mode 3 is selected						
		0 = Ultra DMA mode 3 is not selected						
88	10	1 = Ultra DMA mode 2 is selected	XX7Fh					
		0 = Ultra DMA mode 2 is not selected						
	9	1 = Ultra DMA mode 1 is selected						
		0 = Ultra DMA mode 1 is not selected						
	8	1 = Ultra DMA mode 0 is selected						
		0 = Ultra DMA mode 0 is not selected						
	7	Reserved						
	6	1 = Ultra DMA mode 6 and below are supported						
	5	1 = Ultra DMA mode 5 and below are supported						
	4	1 = Ultra DMA mode 4 and below are supported						



	3 1 = Ultra DMA mode 3 and below are supported							
	3 1 = Ultra DMA mode 3 and below are supported							
	2 1 = Ultra DMA mode 2 and below are supported							
	1 1 = Ultra DMA mode 1 and below are supported							
	0 1 = Ultra DMA mode 0 is supported							
89	Time required for security erase unit completion	0001h						
90	Time required for Enhanced security erase completion	0000h						
91	Current advanced power management value	0000h						
92	Master Password Revision Code	FFFEh						
	Hardware reset result. The contents of bits (12:0) of this word shall change only during							
	the execution of a hardware reset.							
	15 Shall be cleared to zero.							
	14 Shall be set to one.							
	13 1 = device detected CBLID- above ViH							
	0 = device detected CBLID- below ViL							
	12-8 Device 1 hardware reset result. Device 0 shall clear these bits to zero. Device							
	1 shall set these bits as follows:							
	12 Reserved.							
	11 0 = Device 1 did not assert PDIAG							
	1 = Device 1 asserted PDIAG							
	10-9 These bits indicate how Device 1 determined the device number: 00 = Reserved. 01 = a jumper was used.							
0.3	10 = the CSEL signal was used.	VVVVh						
93	11 = some other method was used or the method is unknown.	XXXXh						
	8 Shall be set to one.							
	7-0 Device 0 hardware reset result. Device 1 shall clear these bits to zero. Device							
	0 shall set these bits as follows:							
	7 Reserved.							
	6 0 = Device 0 does not respond when Device 1 is selected.							
	1 = Device 0 responds when Device 1 is selected.							
	5 0 = Device 0 did not detect the assertion of DASP							
	1 = Device 0 detected the assertion of DASP							
	4 0 = Device 0 did not detect the assertion of PDIAG							
	1 = Device 0 detected the assertion of PDIAG							
	3 0 = Device 0 failed diagnostics.							
	1 = Device 0 passed diagnostics.							
	2-1 These bits indicate how Device 0 determined the device number:							
	00 = Reserved.							



	04									
	01 = a jumper was used.									
	10 = the CSEL signal was used.11 = some other method was used or the method is unknown.									
	0 Shall be set to one.									
	U Shall be set to one.									
	15-8 Vendor's recommended acoustic management value.									
94	7-0 Current automatic acoustic management value.	0000h								
95	Stream Minimum Request Size	0000h								
96	Streaming Transfer Time – DMA	0000h								
97	Streaming Access Latency – DMA and PIO	0000h								
98-99	Streaming Performance Granularity									
100-103	Maximum user LBA for 48-bit Address feature set.									
104	Streaming Transfer Time – PIO									
105	Reserved									
	Physical sector size / Logical Sector Size									
	15 Shall be cleared to zero									
	14 Shall be set to one									
106	13 1 = Device has multiple logical sectors per physical sector.	0000h								
	12 1= Device Logical Sector Longer than 256 Words									
	11-4 Reserved									
	3-0 2 ^X logical sectors per physical sector									
107	Inter-seek delay for ISO-7779 acoustic testing in microseconds	0000h								
	15-12 NAA (3:0)									
108	11-0 IEEE OUI (23:12)	0000h								
	15-4 IEEE OUI (11:0)									
109	3-0 Unique ID (35:32)	0000h								
110	15-0 Unique ID (31:16)	0000h								
111	15-0 Unique ID (15:0)	0000h								
112-115	Reserved for world wide name extension to 128 bits	0000h								
116	Reserved for technical report-	0000h								
117-118	Words per Logical Sector	0000h								



119-120	Reserved	0000h
121-126	Reserved	0000h
127	Removable Media Status Notification feature set support 15-2 Reserved 1-0 00 = Removable Media Status Notification feature set not supported 01 = Removable Media Status Notification feature supported 10 = Reserved 11 = Reserved	0000h
128	Security Status 15-9 Reserved 8 Security level 0 = high, 1 = Maximum 7-6 Reserved 5 1 = Enhanced security erase supported 4 1 = Security count expired 3 1 = Security frozen 2 1 = Security locked 1 1 = Security enabled 0 1 = Security supported	0 X 0 0 0 X X X
129-159	Vendor specific	0000h
160	CFA power mode 1 15 Word 160 supported 14 Reserved 13 CFA power mode 1 is required for one or more commands implemented by the device 12 CFA power mode 1 disabled 11-0 Maximum current in ma	0000h
161-175	Reserved for assignment by the CompactFlash™ Association	0000h
176-205	Current media serial number	0000h
206-254	Reserved	0000h
255	Integrity word 15-8 Checksum 7-0 Signature	XXXXh

5.11.5 Idle -97H or E3H

Table 38: Idle information

Register	7	6	5	4	3	2	1	0	
Command(7)	97h or	97h or E3h							
C/D/H(6)	Χ			Drive	Χ				



Cylinder	X
High(5)	
Cylinder Low(4)	X
Sector	X
Number(3)	
Sector Count(2)	Timer Count (5 msec increments)
Feature(1)	X

This command causes the CompactFlash Storage Card to set BSY, enter the IDLE mode, clear BSY and generate an interrupt. If the sector count is non-zero, it is interpreted as a timer count with each count being 5 milliseconds and the automatic power down mode is enabled. If the sector count is zero, the automatic power down mode is disabled. Note that this time base (5 msec) is different from the ATA specification.

5.11.6 Idle immediate – 95H or E1H

Table 39: Idle immediate information

Register	7	6	5	4	3	2	1	0
Command(7)	95h or	E1h						
C/D/H(6)	Χ			Drive	Χ			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	Χ							

This command causes the CompactFlash Storage Card to set BSY, enter the IDLE mode, clear BSY and generate an interrupt.

5.11.7 Read Buffer - E4h

Table 40: Read buffer information

Register	7	6	5	4	3	2	1	0
Command(7)	E4h							
C/D/H(6)	Χ			Drive	Χ			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								



Sector Count(2)	X
Feature(1)	X

The Read Buffer command enables the host to read the current contents of the CompactFlash Storage Card's sector buffer. This command has the same protocol as the Read Sector(s) command.

5.11.8 Read DMA - C8h

Table 41: Read DMA information

Register	7	6	5	4	3	2	1	0		
Command(7)	C8h	C8h								
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)								
Cylinder	Cylinde	Cylinder High (LBA 23-16								
High(5)										
Cylinder Low(4)	Cylinde	er Low (LBA 15-	-8						
Sector	Sector	Numbe	(LBA 7-	0						
Number(3)										
Sector Count(2)	Sector	Sector Count								
Feature(1)	Χ									

This command uses DMA mode to read from 1 to 256 sectors as specified in the Sector Count register. A sector count of 0 request 256 sectors. The transfer begins at he sector specified in the Sector Number Register. When this command is issued the CompactFlash Storage Card sets BSY, puts all or part of the sector of data in the buffer. The Card is then permitted, although not required, to set DRQ, cleat BSY. The Card asserts DMAREQ while data is available to be transferred. The Card asserts DMAREQ while data is available to be transferred. The host then reads the (512 & sector –count) bytes of data from the Card using DMA. While DMAREQ is asserted by the Card, the Host asserts –DMACK while it is ready to transfer data by DMA and asserts –IORD once for each 16 bit word to be transferred to the Host.

Interrupts are not generated on every sector, but upon completion of the transfer of the entire number of sectors to be transferred or upon the occurrence of an unrecoverable error. At command completion, the Command Block Registers contain the cylinder, head and sector number of the last sector read. If an error occurs, the read terminates at the sector where the error occurred. The command Block Registers contain the cylinder, head, and sector number of the sector where the occurred. The amount of data transferred is indeterminate. When a Read DMA command is received by the Card and 8 bit transfer mode has been enabled by the Set Features command, the Card shall return the Aborted error.



5.11.9 Read Sector(s) - 20h

Table 42: Read sector information

Register	7	6	5	4	3	2	1	0		
Command(7)	20h	20h								
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)								
Cylinder	Cylinde	Cylinder High (LBA 23-16)								
High(5)										
Cylinder Low(4)	Cylinde	er Low (LBA 15-	-8)						
Sector	Sector	Numbe	r (LBA 7	7-0)						
Number(3)										
Sector Count(2)	Sector	Count								
Feature(1)	X									

This command reads from 1 to 256 sectors as specified in the Sector Count Register. A sector count of 0 requests 256 sectors. The transfer begins at the sector specified in the Sector Number Register. When this command is issued and after each sector of data (except the last one) has buffer, sets DRQ, cleats BSY, and generates an interrupt. The host then reads the 512 bytes of data from the buffer.

At command completion, the Command Block Registers contain the cylinder, head and sector number of the last sector read. If an error occurs, the read terminates at the sector where the error occurred. The command Block Registers contain the cylinder head, and sector number of the sector 2where the error occurred. The flawed data is pending in the sector buffer.

5.11.10 Read Verify Sector(s) - 40h

Table 43: Read verify sector information

Register	7	6	5	4	3	2	1	0		
Command(7)	40h	40h								
C/D/H(6)	1	1 LBA 1 Drive Head (LBA 27-24)								
Cylinder	Cylinde	Cylinder High (LBA 23-16)								
High(5)										
Cylinder Low(4)	Cylinde	er Low (LBA 15-	·8)						
Sector	Sector	Numbe	r (LBA 7	'-0)						
Number(3)										
Sector Count(2)	Sector	Sector Count								
Feature(1)	Χ									



This command is identical to the Read Sectors command, except that DRQ is never set and no data is transferred to the host. When the command is accepted, the CompactFlash Storage Card sets BSY. When the requested sectors have been verified, the CompactFlash Storage Card clears BSY and generates an interrupt. Upon command completion, the Command Block Registers contain the cylinder, head, and sector number of the last sector verified. If an error occurs, the Read Verify Command terminates at the sector where the error occurs. The Command Block Registers contain the cylinder, head and sector number of the sector where the error occurred. The Sector Count Register contains the number of sectors not yet verified.

5.11.11 Set Features - Efh

Table 44: Set feature information

Register	7	6	5	4	3	2	1	0		
Command(7)	Efh	Efh								
C/D/H(6)	Χ	X Drive X								
Cylinder	X									
High(5)										
Cylinder Low(4)	Χ									
Sector	Χ									
Number(3)										
Sector Count(2)	Config									
Feature(1)	Feature	е								

This command is used by the host to establish or select certain features. If any subcommand input value is not supported or is invalid, the CompactFlash Storage Card shall return command aborted.

Table 45: Feature Supported

Command Name	Code	Sub Command
Set Transfer Mode	Efh	03h
Disable Read Look-ahead	Efh	55h
feature		
Enable write cache	Efh	02h
Disable reverting to power-on	Efh	66h
defaults		
Disable write cache	Efh	82h
Enable reverting to power-on	Efh	CCh



5.11.12 Set Multiple Mode - C6h

Table 46: Set multiple mode information

Register	7	6	5	4	3	2	1	0		
Command(7)	C6h	C6h								
C/D/H(6)	Χ	X Drive X								
Cylinder	Χ									
High(5)										
Cylinder Low(4)	Χ									
Sector	Χ									
Number(3)										
Sector Count(2)	Sector	Count								
Feature(1)	Χ									

This command enables the CompactFlash Storage Card to perform Read and Write Multiple operations and establishes the block count for these commands. The Sector Count Register is loaded with the number of sectors per block. Upon receipt of the command, the CompactFlash Storage Card sets BSY to 1 and checks the Sector Count Register. If the Sector Count Register contains a valid value and the block count is supported, the value is loaded and execution is enabled for all subsequent Read Multiple and Write Multiple commands. If the Sector Count Register contains 0 when the command is issued, Read and Write Multiple commands are disabled. At power on, or after a hardware or (unless disabled by a Set Feature command) software reset, the default mode is Read and Write multiple disabled.

5.11.13 Set Sleep Mode –E6h

Table 47: Set sleep mode information

Register	7	6	5	4	3	2	1	0
Command(7)	E6h							
C/D/H(6)	Χ			Drive	Χ			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	Χ							



This command causes the CompactFlash Storage Card to set BSY, enter the Sleep mode, clear BSY and generate an interrupt. Recovery from sleep mode is accomplished by simply issuing another command (a reset is permitted but not required). Sleep mode is also entered when internal timers expire so the host does not need to issue this command except when it wishes to enter Sleep mode immediately. The default value for the timer is 5 milliseconds.

5.11.14 Standby -E2h

Table 48: Standby information

Register	7	6	5	4	3	2	1	0
Command(7)	E2h							
C/D/H(6)	Χ			Drive	X			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	Χ							

This command causes the CompactFlash Storage Card to set BSY, enter the Sleep mode, cleat BSY and return interrupt immediately. Recovery from sleep mode is accomplished by simply issuing another command (a reset is not required).

5.11.15 Standby Immediate -E0h

Table 49: Standby immediate information

Register	7	6	5	4	3	2	1	0
Command(7)	E0h							
C/D/H(6)	Χ			Drive	Χ			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	Χ							

This command causes the CompactFlash Storage Card to set BSY, enter the Sleep mode, clear BSY and return the interrupt immediately. Recovery from sleep mode is accomplished



by simply issuing another command (a reset is not required).

5.11.16 Write Buffer - E8h

Table 50: Write buffer information

Register	7	6	5	4	3	2	1	0
Command(7)	E8h							
C/D/H(6)	Χ			Drive	Χ			
Cylinder	Χ							
High(5)								
Cylinder Low(4)	Χ							
Sector	Χ							
Number(3)								
Sector Count(2)	Χ							
Feature(1)	X							

The Write Buffer command enables the host to overwrite contents of the CompactFlash Storage Card's sector buffer with any data pattern desired. This command has the same protocol as the Write Sector(s) command and transfer 512 bytes.

5.11.17 Write DMA - Cah

Table 51: Write DMA information

Register	7	6	5	4	3	2	1	0				
Command(7)	Cah	Cah										
C/D/H(6)	1	LBA	1	Drive	Head (LBA 27-	-24)					
Cylinder	Cylinde	Cylinder High (LBA 23-16)										
High(5)												
Cylinder Low(4)	Cylinde	Cylinder Low(LBA 15-8)										
Sector	Sector	Numbe	r (LBA 7	'-0)								
Number(3)												
Sector Count(2)	Sector	Sector Count										
Feature(1)	Χ											

This command uses DMA mode to write from 1 to 256 sectors as specified in the Sector Count register. A sector count of 0 requests 256 sectors. The transfer begins at the sector specified in the Sector Number Register. When this command is issued the CompactFlash Storage Card sets BSY, puts all or part of the sector of data in the buffer. The Card is then permitted, although not required, to set DRQ, clear BSY. The Card asserts DMAREQ while data is available to be transferred. The host then writes the (512*sector count) bytes of data to the Card using DMA. While DMAREQ is asserted by the Card, the host asserts –DMACK while it is ready to transfer data by DMA and asserts –IOWR once for each



16 bit word to be transferred from the Host.

Interrupts are not generated on every sector, but upon completion of the transfer of the entire number of sectors to be transferred or upon the occurrence of an unrecovertable error. At command completion, the Command Block Registers contain the cylinder, head and sector number of the last sector read. If an error occurs, the read terminates at the sector where the error occurred. The Command Block Registers contain the cylinder, head and sector number of the sector where the error occurred. The amount of data transferred is indeterminate. When a write DMA command is received by the Card and 8 bit transfer mode has been enabled by the Set Features command, the Card shall return the Aborted error.

5.11.18 Write Multiple- C5h

5.11.18.1 Command Code

C5h

5.11.18.2 Protocol

PIO data-out

5.11.18.3 Inputs

The LBA mid, LBA High, Device, and LBA Low specify the starting sector address to be written. The Sector Count register specifies the number of sectors to be transferred.

Table 52: Write multiple command for inputs information

Register	7	6	5	4	3	2	1	0				
Features	Na	Na										
Sector Count	Sector	Sector Count										
LBA Low	LBA(7:	LBA(7:0)										
LBA Mid	LBA(15	5:8)										
LBA High	LBA(23	3:16)										
Device	obs	Na	obs	DEV	LBA(27	7:24)						
Command	C5h	C5h										

Sector Count-

Number of sectors to be transferred. A value of 00h specifies that 256 sectors shall be transferred.

LBA Low-

Starting LBA bits (7:0)

LBA Mid-

Starting LBA bits (15:8)



LBA High-

Starting LBA bits (23:16)

Device -

The LBA bit shall be set to one to specify the address is an LBA.

DEV shall specify the selected device.

Bits(3:0) starting LBA bits (27:24)

5.11.18.4 Normal Output

Table 53: Write multiple command for normal output information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device register-

DEV shall specify the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be cleared to zero.

DRQ will be cleared to zero

ERR will be cleared to zero.

5.11.18.5 Error Outputs

An unrecoverable error encountered during the execution of this command results in the termination of the command. The Command Block register contain the address of the sector where the first unrecoverable error occurred. The amount of data transferred is indeterminate.

Table 54: Write multiple command for normal output information

Register	7	6	5	4	3	2	1	0		
Error	Na	WP	MC	IDNF	MCR	ABRT	NM	Na		
Sector Count	Na	Na								
LBA Low	LBA(7:	LBA(7:0)								
LBA Mid	LBA(15	5:8)								
LBA High	LBA(23	LBA(23:16)								



Device	Obs	Na	obs	DEV	LBA(27:24)			
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Error register-

IDNF shall be set to one if a user-accessible address could not be found. IDNF shall be set to one if an address outside of the range user-accessible address is requested if command aborted is not returned.

ABRT shall be set to one if an error, include an ICRC error, has occurred during an Ultra DMA data transfer. ABRT shall be set to one if an address outside of the range of user-accessible address is requested if IDNF is not set to one.

LBA Low, LBA Mid, and LBA High, Device -

Shall be written with the address of first unrecoverable error.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.18.6 Prerequisites

DRDY set to one. If bit 8 of IDENTIFY DEVICE word 59 is cleared to zero, a successful SET MULTIPLE MODE command shall proceed a WRITE MULTIPLE command.

5.11.18.7 Description

This command writes the number of sectors specified in the Sector Count register.

The number of sectors per block is defined by the content of word 59 of the IDENTIFY DEVICE response.

When the WRITE MULTIPLE command is issued, the SECTOR Count register contains the number of sectors (not the number of blocks) requested. The device shall interrupt for each DRQ block transferred.

IF the number of requested sectors is not evenly divisible by the block count, as many full blocks as possible are transferred, followed by a final, partial block transfer. The partial block transfer is for n sectors, where:

N = Remainder (sector count / block count).



If the WRITE MULTIPLE command is received when WRITE MULTIPLE commands are disabled, the Write Multiple operation shall be rejected with command aborted.

Device errors encountered during WRITE MULTIPLE commands are posted after the attempted device write of the block or partial block transferred. The command ends with the sector in error, even if the error was in the middle of a block. Subsequent blocks are not transferred in the event of an error.

The contents of the Command Block Registers following the transfer of a data block that had a sector in error are undefined. The host should retry the transfer as individual requests to obtain valid error information. Interrupt pending is set when the DRQ bit is set to one at the beginning of each block or partial block.

5.11.19 Write Sector(s) - 30h

7 5 4 6 3 2 1 0 Register Command(7) 30h C/D/H(6) LBA 1 Head(LBA 27-24) Drive Cylinder Cylinder High (LBA 23-16) High(5) Cylinder Low(4) Cylinder Low (LBA 15-8) Sector Sector Number (LBA 7-0) Number(3) Sector Count(2) Sector Count Feature(1) Χ

Table 55: Write sector information

This command writes from 1 to 256 sectors as specified in the Sector Count Register. A sector count of zero requests 256 sectors. The transfer begins at the sector specified in the Sector Number Register. When this command is accepted, the CompactFlash Storage Card sets BST, then sets DRQ and clears BSDY, then waits for the host to fill the sector buffer with the data to be written. No interrupt is generated to start the first host transfer operation. No data should be transferred by the host until BSY has been cleared by the host.

For multiple sectors, after the first sector of data is in the buffer, BSY shall be set and DRQ shall be cleared. After the next buffer is ready for data, BSY is cleared, DRQ is set and an



interrupt is generated. When the final sector of data is transferred, BSY is set and DRQ is cleared. It shall remain in this state until the command is completed at which time BSY is cleared and an interrupt is generated. If an error occurs during a write of more than one sector, writing terminates at the sector where the error occurs. The Command Block Registers contain the cylinder, head and sector number of the sector where the error occurred. The host may then read the command block to determine what error has occurred, and on which sector.

5.11.20 Security Set Password- F1h

5.11.20.1 Command Code

F1h

5.11.20.2 Feature Set

Security Mode feature set

5.11.20.3 Protocol

PIO data-out

5.11.20.4 Inputs

Table 56: Security set password command for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	Na	Na			
Command	F1h							

Device -

DEV shall specify the selected device.

Normal Outputs

Table 57: Security set password command for normal outputs information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na			



Status BSY DRDY DF Na	DRQ	Na	Na	ERR
-----------------------	-----	----	----	-----

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be set to zero.

DRQ will be cleared to zero

ERR will be set to zero.

5.11.20.5 Error Outputs

Table 58: Security set password command for error outputs information

Register	7	6	5	4	3	2	1	0		
Error	Na	Na	Na	Na	Na	ABRT	Na	Na		
Sector Count	Na									
LBA Low	Na									
LBA Mid	Na	Na								
LBA High	Na									
Device	obs	Na	obs	DEV	Na					
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR		

Error Register

ABRT may be set to one if the device is not able to complete the action requested by the command

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) should be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.20.6 Prerequisites

DRDY set to one.

5.11.20.7 Description

This command transfer 512 byte of data from the host. Table 10 defines the content of this information. The data transferred controls the function of this command. Table 11 defines the interaction of the identifier and security level bits.



The revision code field shall be returned in the IDENTIFY DEVICE word 92. The valid revision codes are 0001h through FFFEh. A value of 0000h or FFFFh indicates that the Master Password Revision Code is not supported.

Table 59: Security set password command's data content

Word	Content
0	Control Word
	Bit 0 Identifier 0=set User password
	1=set Master password
	Bits (7:1) Reserved
	Bit(8) Security level 0=High
	1=Maximum
	Bits(15:9) Reserved
1-16	Password(32 bytes)
17	Master Password Revision Code()
18-255	Reserved

Table 60: Security Set password command's identifier and security level bit interaction

Identifier	Level	Command result
User	High	The password supplied with the command shall be saved as
		the new User password. The Lock mode shall be enabled
		from the next power-on or hardware reset. The device shall
		than be unlocked by either the User password it the
		previously set Master password.
User	Maximum	The password supplied with the command shall be saved as
		the new User password. The lock mode shall be enabled
		from the next power-on or hardware reset. The device shall
		then be unlocked by only the User password. The Master
		password previously set is still stored in the device but shall
		not be unlock
Master	High or	This combination shall set a Master password but shall not
	Maximum	enable or disable the Lock mode. The security level is not
		changed. Master password revision code set to the value in
		Master Password Revision Code field.

5.11.21 Security Unlock- F2h



5.11.21.1 Command Code

F2h

5.11.21.2 Feature Set

Security Mode feature set

5.11.21.3 Protocol

PIO data-out

5.11.21.4 Inputs

Table 61: Security unlock command for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	Na	Na			
Command	F2h							

Device register-

DEV shall specify the selected device.

Normal Outputs

Table 62: Security unlock command for inputs information

Register	7	6	5	4	3	2	1	0			
Error	Na	Na									
Sector Count	Na	Na									
LBA Low	Na	Na									
LBA Mid	Na	Na									
LBA High	Na										
Device	obs	Na	obs	DEV	Na						
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR			

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be set to zero.

DRQ will be cleared to zero



ERR will be set to zero.

5.11.21.5 Error Outputs

The device shall return aborted if the device is in Frozen mode.

Table 63: Security unlock command for inputs information

Register	7	6	5	4	3	2	1	0		
Error	Na	Na	Na	Na	Na	ABRT	Na	Na		
Sector Count	Na	Na								
LBA Low	Na	Na								
LBA Mid	Na									
LBA High	Na									
Device	obs	Na	obs	DEV	Na					
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR		

Error Register

ABRT may be set to one if the device is not able to complete the action requested by the command

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) should be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.21.6 Prerequisites

DRDY set to one.

5.11.21.7 Description

This command transfers 512 bytes of data from the host. Table13 defines the content of this information. If the Identifier bit is set to Master and the device is in high security level, then the password supplied shall be compared with the stored Master password. If the device is in maximum security level then the unlock shall be rejected.

If the Identifier bit is set to user then the device shall compare the supplied password with the stored User password. If the password compare fails then the device shall return command aborted to the host and decrements the unlock counter. This counter shall be initially set to five and shall decremented for each password mismatch when SECURITY UNLOCK and



SECURITY ERASE UNIT commands shall be command aborted until a power-on reset or a hardware reset. SECURITY UNLOCK commands issued when the device is unlocked have no effect on the unlock counter.

5.11.22 Security Erase Prepare- F3h

5.11.22.1 Command Code

F3h

5.11.22.2 Feature Set

Security Mode feature set

5.11.22.3 Protocol

Non-data

5.11.22.4 Inputs

Table 64: Security erase prepare command for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	Na	Na			
Command	F3h							

Device register-

DEV shall specify the selected device.

Normal Outputs

Table 65: Security erase prepare command for normal outputs information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device register

DEV shall indicate the selected device.

Status register



BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) will be set to zero.

DRQ will be cleared to zero

ERR will be set to zero.

5.11.22.5 Error Outputs

The device shall return aborted if the device is in Frozen mode.

Table 66: Security erase prepare command for error outputs information

Register	7	6	5	4	3	2	1	0
Error	Na	Na	Na	Na	Na	ABRT	Na	Na
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na			
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Error Register

ABRT shall be set to one if the device is in Frozen mode. ABRT may be set to one if the device is not able to complete the action requested by the command

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) should be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.22.6 Prerequisites

DRDY set to one.

5.11.22.7 Description

The SECURITY ERASE PREPARE command shall be issued immediately before the SECURITY ERASE UNIT command to enable device erasing and unlocking. This command prevents accidental loss of data on the device.

5.11.23 Security Erase Unit- F4h

5.11.23.1 Command Code



F4h

5.11.23.2 Feature Set

Security Mode feature set

5.11.23.3 Protocol

PIO data-out.

5.11.23.4 Inputs

Table 67: Security erase unit command for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	Na	Na	Na	Na	Na
Command	F4h							

Device register-

DEV shall specify the selected device.

Normal Outputs

Table 68: Security erase unit command for normal outputs information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device register

DEV shall indicate the selected device.

Status register

BSY shall be cleared to zero indicating command completion

DRDY shall be set to one.

DF (Device Fault) will be set to zero.

DRQ shall be cleared to zero

ERR shall be cleared to zero.

5.11.23.5 Error Outputs



The device shall return aborted if the device is in Frozen mode, not preceded by a SECURITY ERASE PREPARE command, if Enhance Erase is specified but not supported, or if the data area is not successfully overwritten.

Table 69: Security erase unit command for error outputs information

Register	7	6	5	4	3	2	1	0
Error	Na	Na	Na	Na	Na	ABRT	Na	Na
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na			
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Error Register

ABRT shall be set to one if the device is in Frozen mode, not preceded by a SECURITY ERASE PREPARE command, or if the data area is not successfully overwritten. ABRT may be set to one if the device is not able to complete the action requested by the command.

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) should be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.23.6 Prerequisites

DRDY set to one. This command shall be immediately preceded by a SECURITY ERASE PREPARE command.

5.11.23.7 Description

This command transfer 512 bytes of data from the host. Table12 defines the content of this information. If the password does not match the password previously saved by the device, the device shall reject the command with command aborted.

The SECURITY ERASE PREPARE command shall be completed immediately prior to the SECURITY ERASE UNIT command. If the device receives a SECURITY ERASE UNIT command without an immediately prior SECURITY



ERASE PREPARE command, the device shall command abort the SECURITY ERASE UNIT command.

When Normal Erase mode is specified, the SECURITY ERASE UNIT command shall write binary zeroes to all user data areas. The Enhanced Erase mode is optional. When Enhanced Erase Mode is specified, the device shall write predetermined data patterns to all user areas. In Enhanced Erase mode, all previously written user data shall be overwritten, including sectors that are no longer in use due to reallocation.

This command shall disable the device Lock mode, however, the Master password shall still be stored internally within the device and may be reactivated later a new User password is set.

Table 70: Security erase unit password information

Word	Content								
0	Control \	Control Word							
	Bit 0	Identifier	0=Compare User password						
			1= Compare Master password						
	Bit 1	Erase mode	0=Normal Erase						
			1=Enhanced Erase						
	Bit(15:2) Reserved							
1-16	Password	d (32 Bytes)							
17-255	Reserved	d							

5.11.24 Security Freeze Lock- F5h

5.11.24.1 Command Code

F5h

5.11.24.2 Feature Set

Security Mode feature set

5.11.24.3 Protocol

Non-data.

5.11.24.4 Inputs

Table 71: Security freeze lock for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							



LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	Obs	Na	obs	Na	Na	Na	Na	Na
Command	F5h							

Device register-

DEV shall specify the selected device.

Normal Outputs

Table 72: Security freeze lock for normal outputs information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	Obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device register

DEV shall indicate the selected device.

Status register

BSY shall be cleared to zero indicating command completion

DRDY shall be set to one.

DF (Device Fault) will be set to zero.

DRQ shall be cleared to zero

ERR shall be cleared to zero.

5.11.24.5 Error Outputs

The device shall return aborted if the device is in Frozen mode, not preceded by a SECURITY ERASE PREPARE command, if Enhance Erase is specified but not supported, or if the data area is not successfully overwritten.

Table 73: Security freeze lock for error outputs information

Register	7	6	5	4	3	2	1	0
Error	Na	Na	Na	Na	Na	ABRT	Na	Na
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							



LBA High	Na							
Device	Obs	Na	obs	DEV	Na			
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Error Register

ABRT shall be set to one if the device is in locked mode. ABRT may be set to one if the device is not able to complete the action requested by the command.

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) should be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.24.6 Prerequisites

DRDY set to one.

5.11.24.7 Description

The SECURITY FREEZE LOCK command shall set the device to Frozen mode. After command completion any other commands that update the device Lock mode shall be command aborted. Frozen mode shall be disabled by power-off or hardware reset. If SECURITY FREEZE LOCK shall be issued when the device in Frozen mode, the command executes and the device shall remain in Frozen mode.

Command disabled by SECURITY FREEZE LOCK are:

- SECUIRTY SET PASSWORD
- SECURITY UNLOCK
- SECURITY DISABLE PASSWORD
- SECURITY ERASE PREPARE
- SECURITY ERASE UNIT

5.11.25 Security Disable Password- F6h

5.11.25.1 Command Code

F6h

5.11.25.2 Feature Set

Security Mode feature set

5.11.25.3 Protocol

PIO data-out.



5.11.25.4 Inputs

Table 74: Security disable password command for inputs information

Register	7	6	5	4	3	2	1	0
Features	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	Na	Na	Na	Na	Na
Command	F6h							

Device register-

DEV shall specify the selected device.

Normal Outputs

Table 75: Security disable password command for normal outputs information

Register	7	6	5	4	3	2	1	0
Error	Na							
Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device register

DEV shall indicate the selected device.

Status register

BSY shall be cleared to zero indicating command completion

DRDY shall be set to one.

DF (Device Fault) will be set to zero.

DRQ shall be cleared to zero

ERR shall be cleared to zero.

5.11.25.5 Error Outputs

The device shall return aborted if the device is in Locked mode, or device is in Frozen mode.

Table 76: Security disable password command for error outputs information

Register	7	6	5	4	3	2	1	0
Error	Na	Na	Na	Na	Na	ABRT	Na	Na



Sector Count	Na							
LBA Low	Na							
LBA Mid	Na							
LBA High	Na							
Device	obs	Na	obs	DEV	Na			
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Error Register

ABRT may be set to one if the device is not able to complete the action requested by the command.

Device register

DEV shall indicate the selected device.

Status register

BSY will be cleared to zero indicating command completion

DRDY will be set to one.

DF (Device Fault) should be set to one if a device fault has occurred.

DRQ will be cleared to zero

ERR will be set to one if an Error register bit is set to one.

5.11.25.6 Prerequisites

DRDY set to one. Device shall be in Unlocked mode.

5.11.25.7 Description

The SECURITY DISABLE PASSWORD command transfer 512 bytes of data from the host. Table 13 defines the content of this information. If the password selected by word 0 matches the password previously saved by the device, the device shall disable the Lock mode. This command shall not change the Master password. The Master password shall be reactivated when a User password if set.

Table 77: Security disable password command content

Word	Content					
0	Control Word					
	Bit 0 Identifier 0=Compare User password					
	1= Compare Master password					
	Bit(15:1) Reserved					
1-16	Password (32 Bytes)					
17-255	Reserved					

5.11.26 SMART

Individual SMART commands are identified by the value placed in the



Feature register.

Table 78: SMART Feature register values

Value	Command
D0h	SMART Read Data
D8h	SMART ENABLE OPERATIONS
D9h	SMART DISABLE OPERATIONS

5.11.27 SMART Read Data

5.11.27.1 Command Code

B0h with a Feature register value of D0h

5.11.27.2 Feature Set

Smart Feature Set

Operation when the SMART feature set is implemented.

5.11.27.3 Protocol

PIO data-in

5.11.27.4 Inputs

Table 79: SMART command for inputs information

Register	7	6	5	4	3	2	1	0
Features		D0h						
Sector Count				N	a			
LBA Low		Na						
LBA Mid				41	-h			
LBA High				C	2h			
Device	Obs	Na	obs	DEV	Na	Na	Na	Na
Command	B0h							

Device register-

DEV shall specify the selected device.

Normal Outputs

Table 80: SMART command for normal outputs information

Register	7	6	5	4	3	2	1	0
Error		Na						
Sector Count		Na						
LBA Low		Na						
LBA Mid		Na						



LBA High				N	a			
Device	Obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device Register-

DEV shall indicate the selected device.

Status register-

BSY will be cleared to zero indicating command completion.

DRDY will be set to one.

DF (Device Fault) will be cleared to zero.

DRQ shall be cleared to zero.

ERR shall be cleared to zero.

5.11.27.5 Prerequisites

DRDY set to one. SMART enabled.

5.11.27.6 Description

This command returns the Device SMART data structure to the host.

Table 81: SMART data structure

BYTE	Description
0-1	Revision code
2-361	Vendor specific
362	Off-line data collection status
363	Self-test execution status byte
364-365	Total time in seconds to complete
	off-line data collection activity
366	Vendor specific
367	Off-line data collection capability
368-369	SMART capability
370	Error logging capability
	*7-1 Reserved
	*0 1 = Device error logging
	supported
371	Vendor specific
372	Short self-test routine recommended
	polling time (in minutes)
373	Extended self-test routine
	recommended polling time (in
	minutes)
374	Conveyance self-test routine
	recommended polling time (in
	minutes)
375-385	Reserved
386-395	Firmware Version/Date Code
396-399	Reserved



400-406	`SMI2236'
407-511	Reserved
511	Checksum

5.11.28 SMART ENABLE OPERATIONS

5.11.28.1 Command Code

B0h with a Feature register value of D8h

5.11.28.2 Feature Set

Smart Feature Set

5.11.28.3 Protocol

Non-data

5.11.28.4 Inputs

Table 82: SMART Enable command for inputs information

Register	7	6	5	4	3	2	1	0
Features		D8h						
Sector Count				N	a			
LBA Low		Na						
LBA Mid				46	-h			
LBA High				C2	2h			
Device	Obs	Na	obs	DEV	Na	Na	Na	Na
Command	B0h							

Device register-

DEV shall specify the selected device.

5.11.28.5 Normal Outputs

Table 83: SMART command for normal outputs information

Register	7	6	5	4	3	2	1	0
Error		Na						
Sector Count				N	a			
LBA Low		Na						
LBA Mid				N	a			
LBA High				N	a			
Device	Obs	Na	obs	DEV	Na	Na	Na	Na
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR

Device Register-

DEV shall indicate the selected device.

Status register-



BSY will be cleared to zero indicating command completion.

DRDY will be set to one.

DF (Device Fault) will be cleared to zero.

DRQ shall be cleared to zero.

ERR shall be cleared to zero.

5.11.28.6 Prerequisites

DRDY set to one.

5.11.28.7 Description

This command enables access to all SMART capabilities within device.

5.11.29 SMART DISABLE OPERATIONS

5.11.29.1 Command Code

B0h with a Feature register value of D9h

5.11.29.2 Feature Set

Smart Feature Set

5.11.29.3 Protocol

Non-data

5.11.29.4 Inputs

Table 84: SMART DISABLE Command for inputs information

Register	7	6	5	4	3	2	1	0
Features		D9h						
Sector Count				N	a			
LBA Low		Na						
LBA Mid				41	-h			
LBA High				C	2h			
Device	Obs	Na	obs	DEV	Na	Na	Na	Na
Command	B0h							

Device register-

DEV shall specify the selected device.

5.11.29.5 Normal Outputs

Table 85: SMART command for normal outputs information

Register	7	6	5	4	3	2	1	0			
Error		Na									
Sector Count		Na									
LBA Low		Na									



LBA Mid		Na								
LBA High				N	la					
Device	Obs	Obs Na obs DEV Na Na								
Status	BSY	DRDY	DF	Na	DRQ	Na	Na	ERR		

Device Register-

DEV shall indicate the selected device.

Status register-

BSY will be cleared to zero indicating command completion.

DRDY will be set to one.

DF (Device Fault) will be cleared to zero.

DRQ shall be cleared to zero.

ERR shall be cleared to zero.

5.11.29.6 Prerequisites

DRDY set to one. SMART enabled.

5.11.29.7 Description

This command disables all SMART capabilities within device.

6. Device Parameters

ICF 9000 device parameters are listed in Table 86.

Table 86: Device parameter

Capacity	Cylinders	Heads	Sectors	LBA	Capacity(MB)
1GB	1,966	16	63	1981728	967.64
2GB	3,900	16	63	3,931,200	1,919.53
4GB	7,785	16	63	7,847,280	3,831.68
8GB	15,538	16	63	15,662,304	7,647.61
16GB	31,045	16	63	31,293,360	15,279.96
32GB	62,041	16	63	62,537,328	30,535.80
64GB	16,383	15	63	125,059,072	61,064.00



7. Part Number Rule

CODE	1	2	3	4	5			9	10		12	13	14	15	16	17	18	19	20	
CODL	D	C	1	M	-	0 2	2 G	D	7	1	Α	С	1	Q	В	-	3	X	X	
Descriptio n	Dis k	i(CF90	00	-	Cap	acity	C	Category		FW	Operatio al Ch. Flash Internal Code Customized Co								
Defir										itior	1									
Code 1 st (Disk)								Code 12 th (Firmware version)												
D : Disk								A: Standard FW												
С	ode	2 ⁿ	d ~ 4	4 th (Fo	rm	Fact	or)				Code 13	3 th (Op	era	tion	Ten	npera	ture))	
C1M : CF, Ty _l	pe I,										C : St	andard Gr	ade (0 ^	· +7	0 ℃)					
C1S : CF Wri	ite Pı	oted	ct								W:In	dustrial G	rade (-4	ł0 ~	+85 °	°C)				
	Со	de	6 th ′	∨8 th	(C	ара	city)				Code 1	.4 th (Iı	nter	rnal (Cont	rol C	ode)		
01G : 1GB											1: TSOP 1st PCB version, default setting									
02G : 2GB											A: BGA 1 st PCB version, default setting									
04G : 4GB																				
08G : 8GB											Code 15 th (Channel of data transfer)									
16G: 16GB											D: Dual Channel									
32G : 32GB											Q: Quad Channel									
64G : 64GB											Code 16 th (Flash Type)									
											B: Toshiba SLC									
Code 9th ^	11	th	(Se	ries)						Code 18th (Internal Code/ Customized Code)									
D71: iCF 90	D71: iCF 9000										3: Removable Mode +UltraDMA									
										4: Preformat, Fixed Mode + PIO Mode 4										
											5: Pre-formatted + UltraDMA 4									
										6: Pre-formatted + Removable +UltraDMA 6										
											7: Fixed Mode + PIO Mode 4									
											8: Fixed Mode + MwDMA Mode 2									
											9: Removable Mode + PIO Mode 4 A: Preformat									
											A. Pre	ioiiiiat								







CERTIFICATE

Issued Date: June 29, 2012

Report No.: 126319R-ITCEP07V04

This is to certify that the following designated product

Product : iCF9000 Trade name : InnoDisk

Model Number : DC1M-XXXD71#&*%\$, DC1F-XXXD71#&*%\$,

DC15-XXXD71#&*%\$

Company Name : Innodisk Corporation.

This product, which has been issued the test report listed as above in QuieTek Laboratory, is based on a single evaluation of one sample and confirmed to comply with the requirements of the following EMC standard.

EN 55022:2010 Class B

EN 61000-3-2: 2006+A2: 2009

EN 61000-3-3: 2008

EN 55024: 2010

IEC 61000-4-2: 2008

IEC 61000-4-3: 2010

IEC 61000-4-4: 2011

IEC 61000-4-5: 2005

IEC 61000-4-6: 2008

IEC 61000-4-8: 2009

IEC 61000-4-11: 2004

TEST LABORATORY

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CERTIFICATE

Issued Date: Junu 29, 2012 Report No.: 126319R-ITUSP01V02

This is to certify that the following designated product

Product : iCF9000 Trade name. : InnoDisk

Model Number : DC1M-XXXD71#&*%\$, DC1F-XXXD71#&*%\$,

DC1S-XXXD71#&*%\$

Company Name: Innodisk Corporation

ATE

O12
TUSPO1V02

duct

OXD71#&*%\$,

It listed as above in QuieTek
sample and confirmed to
C standard.

Ilass B, CISPR 22: 2008

TEST LABORATORY
Vincent Lin / Manager This product, which has been issued the test report listed as above in QuieTek Laboratory, is based on a single evaluation of one sample and confirmed to comply with the requirements of the following EMC standard.

FCC CFR Title 47 Part 15 Subpart B: 2011, Class B, CISPR 22: 2008 ANSI C63.4: 2009

No.5-22, Ruishukeng, Linkou Dist., New Taipei City 24451, Taiwan, R.O.C. QuieTek TEL:+886-2-8601-3788 FAX:+886-2-8601-3789 Email:service@quietek.com http://www.quietek.com



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REACH Declaration of Conformity

Manufacturer Products: All Innodisk EM Flash and Dram products

1. 宜鼎國際股份有限公司(以下稱本公司)特此保證此售予費公司之產品,皆符合歐盟化學品法案(Registration, Evaluation and Authorization of Chemicals; REACH)之规定 (http://www.echa.europa.eu/de/candidate-list-table last updated: 16/12/2013)。所提供之產品包含:(1)產品或產品所使用到的所有原物料;(2)包裝材料;(3)設計、生產及重工過程中所使用到的所有原物料。

We Innodisk Corporation hereby declare that our products are in compliance with the requirements according to the REACH Regulation

(http://www.echa.europa.eu/de/candidate-list-table last updated: 16/12/2013).

Products include: 1) Product and raw material used by the product: 2) Packaging material; 3) Raw material used in the process of design, production and rework

2.本公司同意因本保證書或與本保證書相關事宜有所爭議時,雙方宜友好協商,達成協議。

InnoDisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

立 保 醬 書 人 (Guarantor)

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Company Representative 公司代表人:__Richard Lee 李鐘亮

Company Representative Title 公司代表人職稱: CEO 執行長

Date 日期: <u>2014 / 03 / 18</u>





宜鼎國際股份有限公司 Innodisk Corporation

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: http://www.innodisk.com/

ROHS 自我宣告書(RoHS Declaration of Conformity)

Manufacturer Product: All Innodisk EM Flash and Dram products

一、宜鼎國際股份有限公司(以下稱本公司)特此保證售予責公司之所有產品,皆符合歐盟 2011/65/EU 關於 RoHS 之規範要求。

Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) requirement

二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時,雙方宜友好協商,達成協議。

Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
Cd	< 100 ppm
Pb	< 1000 ppm
Hg	< 1000 ppm
Chromium VI (Cr+6)	< 1000 ppm
Polybromodiphenyl ether (PBDE)	< 1000 ppm
Polybrominated Biphenyls (PBB)	< 1000 ppm

立 保 整 書 人 (Guarantor)

Company name 公司名稱: Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人: Richard Lee 李鐘亮

Company Representative Title 公司代表人職稱: <u>CEO 執行長</u>

